

## **AS3636**

## Preliminary Datasheet, Confidential

## Xenon Driver IC with LED Driver and Life Time Counter

# **General Description**

The AS3636 is a highly integrated photoflash charger including IGBT driver, inductive DCDC boost autofocus/ video LED driver, an indicator LED driver and it includes system level ESD protection and a breakable fuse.

The AS3636 includes flash timeout, over- and undervoltage, overtemperature and LED short circuit protection functions. To reduce production test time a broken transformer or a broken coil is detected.

The AS3636 is controlled by an I<sup>2</sup>C interface with a dedicated STROBE input. Additionally the TORCH input controls the torch function. An interrupt output is available to signal an error condition to the controller.

The device includes 11 Bytes EEPROM, and an automatic life time counter to count the number of flashes performed.

The AS3636 is available in a space-saving WL-CSP package and operates over the -30°C to +85°C temperature range.

**Warning:** Lethal voltages are present on applications using AS3636! Do not operate without training to handle high voltages.

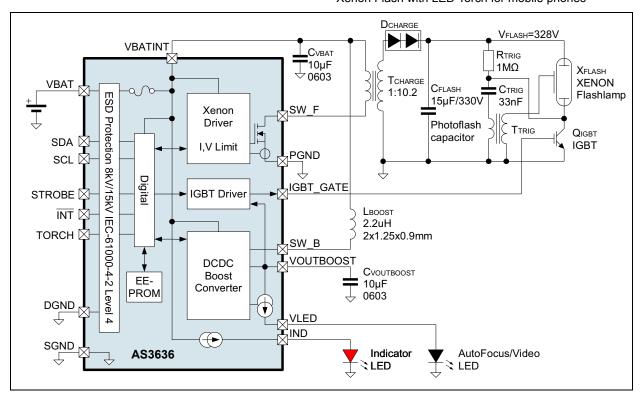
Figure 1. AS3636 Typical Operating Circuit

# 2 Key Features

- Xenon driver
  - Adjustable recharge timings
  - Adjustable current limits
  - In-production trimmable end of charge voltage
  - Photosensor support
- IGBT Driver
  - Trimmable IGBT voltages
  - Trimmable IGBT driving waveform
  - Internal flash duration timer
  - External STROBE input
- DCDC Boost Converter
  - Autofocus/video LED current source
  - Voltage supply for IGBT
- Integrated one time breakable fuse in supply path
- Integrated system level ESD protection according to IEC-61000-4-2 Level 4 (8kV contact, 15kV air dis-
- Available in tiny WL-CSP Packages 4x4 balls 0.5mm pitch, 2.0 x 2.15 x 0.6 mm

# 3 Applications

Xenon Flash with LED Torch for mobile phones

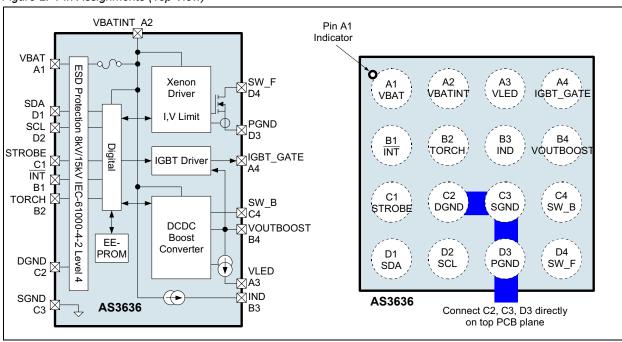




## 4 Pinout

## **Pin Assignment**

Figure 2. Pin Assignments (Top View)



# **Pin Description**

Table 1. Pin Description for AS3636

| Pin Number | Pin Name  | Description   |
|------------|-----------|---|
| A1         | VBAT      | Power supply voltage input  |
| A2         | VBATINT   | Fuse output and internal power supply input - make a short connection to capacitor CVBAT  |
| А3         | VLED      | Autofocus (AF) / Torch LED output   |
| A4         | IGBT_GATE | Drive signal output for IGBT Transistor   |
| B1         | ĪNT       | Interrupt output, open drain, active low  |
| B2         | TORCH     | Torch signal input pin; internal pulldown resistor; connect to GND if not used  |
| В3         | IND       | (Red) Indicator LED output - connect to GND if not used (set ILP=0)   |
| B4         | VOUTBOOST | DCDC Boost converter output - make a short connection to CVOUTBOOST   |
| C1         | STROBE    | Strobe signal input pin to synchronize the flash pulse - usually connected to the camera processor; internal pulldown resistor to GND |
| C2         | DGND      | Digital ground supply - connect directly to ground (GND)  |
| C3         | SGND      | Analog signal ground - connect directly to ground (GND)   |
| C4         | SW_B      | DCDC Boost converter switching node - connect to coil LBOOST  |
| D1         | SDA       | serial data input for I <sup>2</sup> C interface  |
| D2         | SCL       | serial clock input for I <sup>2</sup> C interface   |
| D3         | PGND      | Power ground for Xenon and DCDC Boost - connect directly to ground (GND)  |
| D4         | SW_F      | Xenon DCDC converter switching node - connect to transformer TCHARGE  |



# 5 Absolute Maximum Ratings

Stresses beyond those listed in Table 2 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Table 3, "Electrical Characteristics," on page 4 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

| Parameter  | Min  | Max               | Units    | Comments  |
|--|------|-------------------|----------|---|
| VBAT, VBATINT to GND   | -0.3 | +7.0              | V        |   |
| SDA, SCL, STROBE, INT, TORCH, IGBT_GATE, SW_B, VOUTBOOST, VLED, IND to GND | -0.3 | VBATIN<br>T + 0.3 | <b>V</b> | max. 7.0V   |
| SW_F to GND  | -0.3 | +55.0             | V        |   |
| VOUTBOOST to SW_B  | -0.3 |                   | >        | Note: Diode between VOUTBOOST and SW_B  |
| SGND, DGND, PGND to GND  | 0.0  | 0.0               | ٧        | Connect SGND, DGND and PGND to<br>GND directly below the pad (short<br>connection required) |
| Input Pin Current without causing latchup                                  | -100 | +100<br>+lin      | mA       | Norm: EIA/JESD78  |
| Continuous Power Dissipation (T <sub>A</sub> = +70°C)                      |      |                   |          |   |
| Continuous power dissipation   |      | 1                 | W        | Рт <sup>1</sup>   |
| Continuous power dissipation derating factor                               |      | 14.7              | mW/°C    | PDERATE <sup>2</sup>  |
| Electrostatic Discharge  |      |                   |          |   |
|  |      | ±15000            | V        | Air Discharge to  |
| ESD pins VBAT, SDA, SCL, STROBE, INT,                                      |      | 110000            | V        | module; IEC 61000 -4 -2 test bench <sup>3</sup>   |
| TORCH  |      | ±8000             | V        | Contact Test to module;   |
|  |      | 2000              | •        | IEC 61000 -4 -2 test bench <sup>3</sup>   |
| ESD HBM  |      | ±2000             | V        | Norm: MIL 883 E Method 3015   |
| ESD CDM  |      | ±500              | V        | Norm: JEDEC JESD 22-C101C   |
| ESD MM   |      | ±100              | V        | Norm: JEDEC JESD 22-A115-A level A  |
| Temperature Ranges and Storage Condition                                   | ıs   |                   |          |   |
| Junction Temperature   |      | +150              | °C       | Internally limited (overtemperature protection)   |
| Storage Temperature Range  | -55  | +125              | ô        |   |
| Humidity   | 5    | 85                | %        | Non condensing  |
| Body Temperature during Soldering  |      | +260              | °C       | according to IPC/JEDEC J-STD-020C   |
| Fuse   |      |                   |          |   |
| Fuse Melting time - IFUSE_LIMIT  |      | 1000              | ms       | at 1.5A   |
| 1 doc Michael and - 1703E_LIMIT  | typ. | 100               | ms       | at 2A   |
| Fuse operating current - IFUSE   |      | 650               | mA       |   |

Depending on actual PCB layout and PCB used; for peak power dissipation during flashing see document 'AS3636 Thermal Measurements'

<sup>2.</sup> PDERATE derating factor changes the total continuous power dissipation (PT) if the ambient temperature is not 70°C. Therefore for e.g. TAMB=85°C calculate PT at 85°C = PT - PDERATE \* (85°C - 70°C)

<sup>3.</sup> Assembled on PCB board (requires capacitor CVBAT); system test for completed module (fully capsuled), no permanent interruption of operation; proper layout required



# **6 Electrical Characteristics**

VBAT = +2.7V to +5.5V, TAMB = -30°C to +85°C, unless otherwise specified. Typical values are at VBAT = +3.7V, TAMB = +25°C, unless otherwise specified.

Table 3. Electrical Characteristics

| Symbol                 | Parameter                                 | Condition   | Min            | Тур           | Max                                   | Unit |
|------------------------|---|---|----------------|---------------|---------------------------------------|------|
| General Ope            | erating Conditions                        |   |                |               |                                       |      |
| VBAT                   | Supply Voltage                            |   | 2.7            | 3.7           | 4.4                                   | V    |
| VBATFUNCT<br>IONAL     | Supply Voltage                            | AS3636 functionally working, but not all parameters fulfilled   | 2.3            |               | 5.5 <sup>1</sup>                      | V    |
| ISHUTDOWN <sup>2</sup> | Shutdown Current                          | Shutdown or standby mode, VBAT<3.7V   |                | 0.5           | 1.0                                   | μΑ   |
| ISTANBY <sup>1</sup>   | Standby Current                           | 0°C < TAMB < 50°C   |                | 0.5           | TBD                                   | μΛ   |
| ISTROBEWAI<br>T        | Current when AS3636 is waiting for strobe | DCDC operating, IGBT driver enabled   |                | 5             |                                       | mA   |
| Тамв                   | Operating<br>Temperature                  |   | -30            | 25            | 85                                    | °C   |
|                        |   | Falling Vvเท  | 2.1            | 2.2           | 2.3                                   | V    |
| Vuvlo                  | Undervoltage Lockout                      | Rising V∨ıN   | Vuvlo<br>+0.05 | Vuvlo<br>+0.1 | Vuvlo<br>+0.15                        | V    |
| Тоутемр                | Overtemperature Protection                | Junction temperature  |                | 144           |                                       | °C   |
| TOVTEMPHY<br>ST        | Overtemperature<br>Hysteresis             | Junction temperature  |                | 5             |                                       | °C   |
| Fuse                   |   |   |                |               |                                       |      |
| RFUSE                  | Fuse resistance                           | Fuse melting times: see Table 2 on page 3   |                |               | 0.2                                   | Ω    |
| EEPROM                 |   |   |                |               |                                       |      |
| tee_write              | EEPROM writing time                       |   | 10             | 14.5          | 24                                    | ms   |
| Xenon Capa             | citor Charger                             |   |                |               | •                                     |      |
| VTRIPRANGE             | Programming range of VTRIP                | 6 bit programming measured on pin SW_F<br>Allows in-circuit trimming of the final charged<br>voltage VFLASH on capacitor CFLASH | 28.5           |               | 34.8                                  | V    |
| Vann                   | Comparator trip                           | VFLASH=328V, TJ=15°C50°C using nominal valued components  | -0.5           |               | +0.5                                  | %    |
| Vtrip∆                 | voltage accuracy                          | VFLASH=328V using nominal valued components   | -1.5           |               | +0.5                                  | %    |
| η                      | Charging Efficiency                       | System Target only; depends on external components used   | 60             |               |                                       | %    |
| Vsw                    | Maximum voltage on pin SW                 |   |                |               | 50                                    | V    |
|                        |   | Accuracy at typical setting   | -10%           | 750           | +10%                                  | mA   |
| Isw                    | Switching current limit                   | Adjustable range by register switch_current_selection (see page 29)   | 375            | 750           | 900                                   | mA   |
| teoc_det               |   | end of charge comparator trigger time - see<br>Figure 4, "AS3636 Internal Circuit," on page 9                                   | 128            | 138           | 148                                   | ns   |
| DCDC Step              | Up Converter                              |   |                |               | · · · · · · · · · · · · · · · · · · · |      |
| Vvoutboos              | DCDC Boost output<br>Voltage (pin         | Voltage feedback mode (e.g. if used for IGBT driver)  | 4.75           | 5.0           | 5.25                                  | V    |
| Т                      | VOUTĔOÖST)                                | Current feedback mode; max. VVOUTBOOSTMAX   | V              | LED+0.        | 4                                     | V    |



Table 3. Electrical Characteristics (Continued)

| Symbol            | Parameter   | Condition   | Min                              | Тур  | Max            | Unit                |     |
|-------------------|---|---|----------------------------------|------|----------------|---------------------|-----|
| fclk              | Operating Frequency                                 | All internal timings are derived from this oscillator                             | -7.5%<br>-5.0%                   | 2.0  | +7.5%<br>+5.0% | MHz                 |     |
| AF LED Driv       | /er   |   | -3.0 /0                          |      | 13.070         |                     |     |
| IVLED             | VLED current source output                          | Adjustable by AF_LED<br>limited to Max_LED_                                       | 10.0                             |      | 80.0           | mA                  |     |
| ÍVLEDΔ            | VLED current source accuracy                        |   |                                  | -7.5 |                | +7.5                | %   |
| VVLED             | VLED forward voltage                                |   |                                  | 1.7  |                | 3.6                 | V   |
| VVLED_COM P       | Current Source<br>Compliance                        | VOUTBOOST-VLED current compliance   | source voltage                   |      | 200            | 350                 | mV  |
| Red privacy       | indicator LED (pin INI                              | D)  |                                  | •    | •              |                     |     |
| lind              | IND current source output                           | adjustable by IND_LEI   | _                                | 2    |                | 16                  | mA  |
| lindΔ             | IND current source accuracy                         | VBATINT > 2.7V, indicator LEC<br>between 1.3V and 2.4V (e.g                       | forward voltage<br>use red LED)  | -10  |                | +10                 | %   |
| IGBT Driver       | (pin IGBT_GATE)                                     |   |                                  |      |                |                     |     |
| RIGBT_GATE        | Output driver series resistance                     | measured at IGBT_fall_spee<br>V(IGBT_GATE)=0                                      | ed2zero=50mA,<br>0.8V            | 17   | 20             | 23                  | Ω   |
|                   | resistance  | all current settings and ou   | tput voltages                    | 17   | 20             |                     | Ω   |
| IIGBT_RISE        | IGBT_GATE rise current                              | For a IGBT with 10nF gate cap<br>in 0.5V/µs(5mA)8V/µs(80m/<br>IGBT_rise_and_fall_ | 10                               |      | 80             | mA                  |     |
| ligbt_fall        | IGBT_GATE fall current                              | IGBT_fall_speed2zero, IGBT<br>Driving to Vvouтвооsт (typ.<br>voltage feedback n   | _fall2zero_slow<br>5.0V, DCDC in | 5    |                | 80                  | mA  |
| Protection a      | and Fault Detection Fu                              | nctions   |                                  |      |                |                     |     |
| VVOUTBOOS<br>TMAX | DCDC Boost maximum voltage                          | in current feedback   | mode                             | 4.75 |                | 5.5                 | V   |
|                   | Current Limit for coil                              |   | 00b                              |      | 0.25           |                     |     |
| Ішміт             | LBOOST (Pin SW_B) measured at 50%                   | coil_peak_current=  | 01b                              | -10% | 0.3            | +10%                | Α   |
| ILIMIT            | PWM duty cycle <sup>3</sup>                         |   | 10b                              | 1070 | 0.35           | 1070                | , , |
|                   | . Trini daty by ole                                 |   | 11b                              |      | 0.4            |                     |     |
| VVLEDSHOR<br>T    | AF LED short circuit detection voltage              | Voltage measured on լ   | oin VLED                         |      | 1.2            | 1.65                | V   |
| VVLEDOPEN         | AF LED open circuit detection voltage               | Voltage measured on լ   | pin VLED                         |      | 4.0            |                     | V   |
| VINDSHORT         | Indicator LED short<br>circuit detection<br>voltage | Voltage measured on   | pin IND                          |      | 0.7            | 1.2                 | V   |
| IIND_OUT<br>OPEN  | IND current open detection                          | Detection threshold for or detection on pin                                       |                                  | 45   |                | % of<br>IND_O<br>UT |     |
| Digital Inter     | face  |   |                                  |      |                |                     |     |
| VIH               | High Level Input<br>Voltage                         | Ding CDA COL TO   | 1.26                             |      | VBAT           | V                   |     |
| VIL               | Low Level Input<br>Voltage                          | Pins SDA, SCL, TO   | J.CII                            | 0.0  |                | 0.54                | V   |



Table 3. Electrical Characteristics (Continued)

| Symbol                    | Parameter  | Condition  |                   | Min                       | Тур    | Max   | Unit |
|---------------------------|--|--|-------------------|---------------------------|--------|-------|------|
| VIHSTROBE                 | High Level Input<br>Voltage                            | Pin STROBE   | 0.74              |                           | VBAT   | V     |      |
| VILSTROBE                 | Low Level Input<br>Voltage                             | FIII 3 TROBE   | 0.0               |                           | 0.54   | V     |      |
| Vol                       | Low Level Output<br>Voltage                            | Pins INT and SDA; Io   | oL=3mA            |                           |        | 0.2   | V    |
| ILEAK                     | Leakage current  | Pins SDA, SCL, Ī   | NT                | -10                       |        | +10   | μΑ   |
| Rpulldown                 | Pulldown resistor to                                   | Pins TORCH and STROBE  | at 1.8V           | 35                        | 48     | 65    | kΩ   |
| TYPOLLDOWN                | GND  | Tills TOROTT and OTROBE  | at 1.2V           |                           | 37.5   |       | kΩ   |
| tDEBTORCH                 | TORCH debounce time                                    |  |                   | 6.3                       | 9      | 11.7  | ms   |
| tstrobe_min               | STROBE minimum timing                                  |  |                   |                           | 200    |       | ns   |
| I <sup>2</sup> C mode tir | nings - see Figure 3 or                                | n page 7   |                   |                           |        |       |      |
| tтімеоит                  | SCL timeout  | In active mode, if SCL is low f device enters shutdown mode "AS3636 operating mode," | e - see Figure 5. | 35                        |        | 100   | ms   |
| fsclk                     | SCL Clock Frequency                                    |  |                   | 30                        |        | 400k  | Hz   |
| t <sub>BUF</sub>          | Bus Free Time<br>Between a STOP and<br>START Condition |  |                   | 1.3                       |        |       | μs   |
| t <sub>HD:STA</sub>       | Hold Time (Repeated) START Condition <sup>4</sup>      |  |                   | 0.6                       |        |       | μs   |
| $t_{LOW}$                 | LOW Period of SCL<br>Clock                             |  |                   | 1.3                       |        |       | μs   |
| t <sub>HIGH</sub>         | HIGH Period of SCL<br>Clock                            |  |                   | 0.6                       |        |       | μs   |
| tsu:sta                   | Setup Time for a<br>Repeated START<br>Condition        |  |                   | 0.6                       |        |       | μs   |
| t <sub>HD:DAT</sub>       | Data Hold Time <sup>5</sup>                            |  |                   | 0                         |        | 0.9   | μs   |
| t <sub>SU:DAT</sub>       | Data Setup Time <sup>6</sup>                           |  |                   | 100                       |        |       | ns   |
| t <sub>R</sub>            | Rise Time of Both<br>SDA and SCL Signals               |  |                   | 20 +<br>0.1C <sub>B</sub> |        | 300   | ns   |
| t <sub>F</sub>            | Fall Time of Both SDA and SCL Signals                  |  |                   | 20 +<br>0.1C <sub>B</sub> |        | 300   | ns   |
| t <sub>SU:STO</sub>       | Setup Time for STOP<br>Condition                       |  |                   | 0.6                       |        |       | μs   |
| C <sub>B</sub>            | Capacitive Load for<br>Each Bus Line                   | C <sub>B</sub> — total capacitance of one  | e bus line in pF  |                           |        | 400   | pF   |
| C <sub>I/O</sub>          | I/O Capacitance<br>(SDA, SCL)                          |  |                   |                           |        | 10    | pF   |
|                           | r Parameters - only users on page 37                   | e transformers approved by a   | ustriamicrosyst   | ems, se                   | e Reco | mmend | ed   |
| LPRIMARY                  | Primary Inductance                                     |  |                   | 6                         |        |       | μH   |
| LLEAK                     | Primary Leakage<br>Inductance                          |  |                   |                           |        | 0.4   | μH   |
|                           |  |  |                   | 1                         |        |       |      |



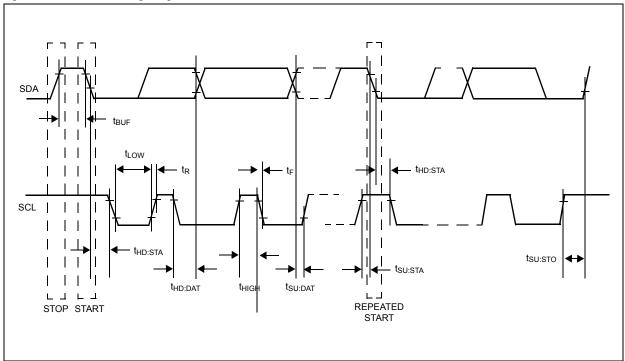
Table 3. Electrical Characteristics (Continued)

| Symbol         | Parameter                       | Condition   | Min  | Тур  | Max | Unit |
|----------------|---------------------------------|---|------|------|-----|------|
| N              | Turns Ratio                     | for VFLASH=330V (final charged voltage on CFLASH) |      | 10.2 |     |      |
| VISOLATION     | Isolation Voltage               |   | 500  |      |     | V    |
| ISATURATION    | Primary Saturation<br>Current   |   | 0.84 |      |     | Α    |
| RPRIMARY       | Primary Winding<br>Resistance   |   |      |      | 0.4 | Ω    |
| RSECUNDAR<br>Y | Secondary Winding<br>Resistance |   |      |      | 60  | Ω    |

- 1. The overvoltage protection of the DCDC step up converter (pin VOUTBOOST) will trigger above 5.4V thus shutting down the DCDC converter.
- 2. ISHUTDOWN or ISTANBY includes leakage current for SW\_B and SW\_F.
- 3. Due to slope compensation of the current limit, ILIMIT changes with duty cycle.
- 4. After this period, the first clock pulse is generated.
- 5. A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the V<sub>IHMIN</sub> of the SCL signal) to bridge the undefined region of the falling edge of SCL.
- 6. A fast-mode device can be used in a standard-mode system, but the requirement  $t_{SU:DAT}$  = to 250ns must then be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_R$  max +  $t_{SU:DAT}$  = 1000 + 250 = 1250ns before the SCL line is released.

## **Timing Diagrams**

Figure 3. I<sup>2</sup>C mode Timing Diagram





# 7 Typical Operating Characteristics

VBAT = 3.7V, TAMB = +25°C (unless otherwise specified)

Charging Waveform (VFLASH vs. time at 2.7V, 3.7V, 4.2V; IVBAT vs. time)

Charging time (time[s] vs. VVBAT)

VFLASH Output voltage vs. VVBAT (at -30°C, 25°C, 85°C)

VFLASH Output voltage vs. TAMB

Switching waveform details (single cycle: Vsw\_F, IVBAT)

IGBT Drive waveforms for short pulses (e.g. 5µs) STROBE, IGBT\_GATE vs. time

DCDC Boost Efficiency vs. VVBAT

DCDC Boost Application Efficiency (PLED/PVBAT) vs. VVBAT

IVBAT startup for Torch/AF LED

IVLED output vs. TAMB in Assist mode

Oscillator frequency fclk vs. TAMB

TBD



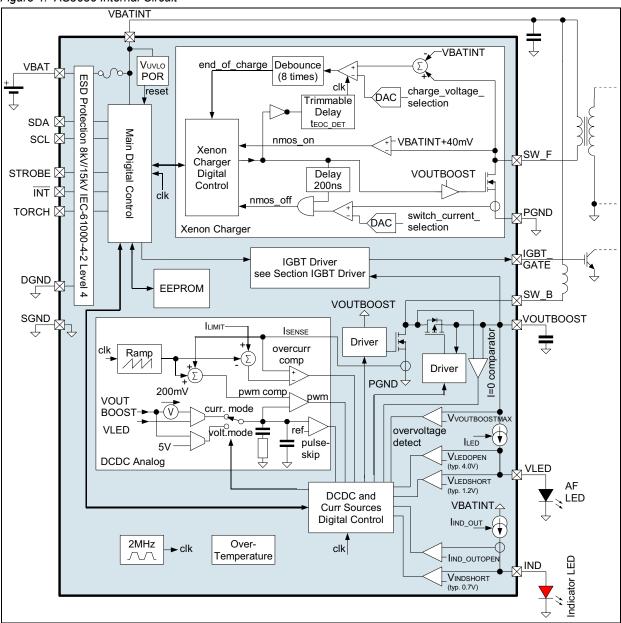
# 8 Detailed Description

The AS3636 is a highly integrated photoflash charger with build in IGBT driver, inductive DCDC boost autofocus/video LED driver, an indicator LED driver and it includes system level ESD protection and a breakable fuse. The integrated fuse will be blown if there is short circuitry in the module <sup>1</sup>. It is not reversible.

Note: The AS3636 uses a WL-CSP (wafer level chip scale package) to optimize the PCB area required and minimize the module size. Therefore the actual DIE is visible (and it is not molded in plastic as for other packages like QFN or DFN) and the AS3636 is sensitive to external light. It has to be protected from direct light from the Xenon tube.

#### **Internal Circuit**

Figure 4. AS3636 Internal Circuit

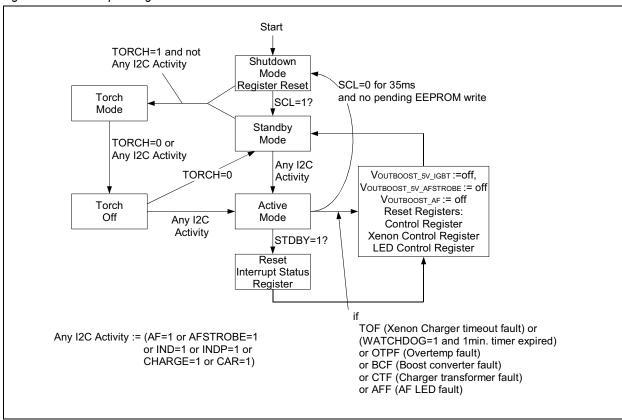


1. The purpose is to fulfill the IEC60065 safety requirements (see section 14.5.4).



## **Operating modes**

Figure 5. AS3636 operating mode

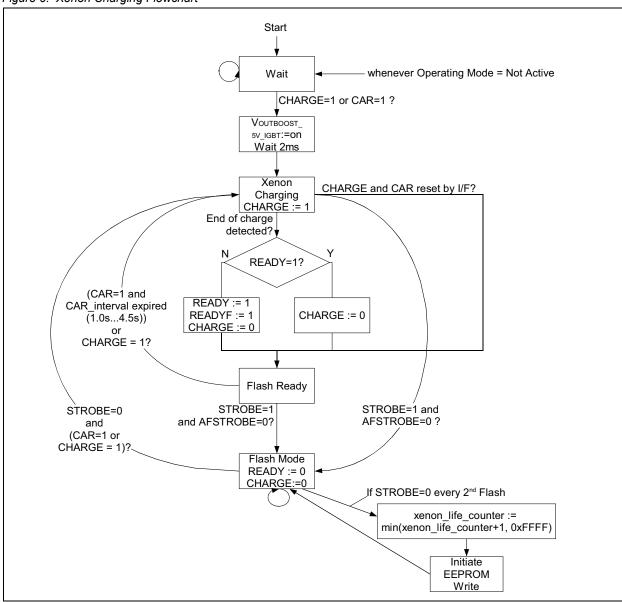


The internal operating modes are chosen according to the flowchart in Figure 5. The xenon charging procedure is described in Figure 6.

The AS3636 wakes up from shutdown mode by sensing its bus. If SCL raises, the AS3636 enters standby modes and the I<sup>2</sup>C interface is operating. If any activity is sensed (any of the register bits AF, AFSTROBE, IND, INDP, CAR or CHARGE is set), the AS3636 enters active mode.



Figure 6. Xenon Charging Flowchart



Upon setting of CHARGE (see page 26) or CAR, VOUTBOOST is boosted to 5V<sup>2</sup>, the Xenon capacitor charging is started. Once finished, charging is stopped (CHARGE is reset), READY and READYF s set and the interrupt line INT is pulled low (if not disabled by READYFI). Upon STROBE<sup>3</sup> a flash is started.

Upon release of STROBE and if the register bit CAR<sup>4</sup>=1 an automatic recharge cycle is started.

Every second flash cycle, the internal life time counter(xenon\_life\_counter\_MSB and xenon\_life\_counter\_LSB) inside the EEPROM (see EEPROM Writing Cycle on page 13) is updated to count the number of flash for the attached Xenon tube.

If no flash is triggered for CAR\_interval time (can be set between 1.0s to 4.5s) and CAR = 1, the capacitor is automatically recharged.

<sup>2.</sup> Using the internal signal Voutboost\_5v\_IGBT - see DCDC Boost Converter VOUTBOOST on page 12

<sup>3.</sup> Using the register bit STROBE or the input signal STROBE

<sup>4.</sup> Capacitor Automatic Recharge



Standby mode is entered upon following conditions and Xenon Control Register, LED Control Register, Control Register and Interrupt Status Register<sup>5</sup> are reset to their default:

- 1. STDBY is set to 1
- 2. Any fault condition (TOF, CTF, BCF, OTPF, AFF or ILF)
- 3. No flash is triggered within one minute and WATCHDOG=1

By writing '1' into register RESET, all registers can be reset to their default.

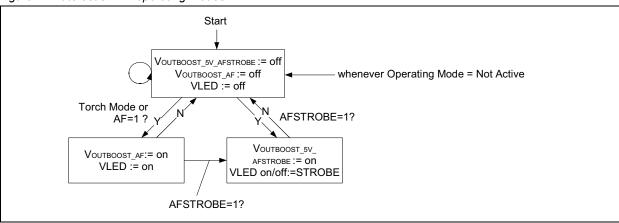
In active mode, if SCL = 0 for 35ms and an EEPROM write is not pending, all registers are reset to their default values and shutdown mode is entered reducing current consumption to a minimum.

#### Autofocus (AF) LED on pin VLED operating modes

The AF LED can be enabled with the TORCH input or the AF register bit or gated by the STROBE input if AFSTROBE is set. If AFSTROBE is used, the DCDC converter is always run at  $5V^6$  to allow for immediate reaction to the STROBE input signal (within  $\mu$ s). The AFSTROBE register bit has priority over AF signal or TORCH input.

If AF or AFSTROBE is used and WATCHDOG=1, the AF LED and DCDC boost converter is automatically disabled after one minute. Any read or write access to any AS3636 register resets this watchdog timer.

Figure 7. Autofocus LED operating modes

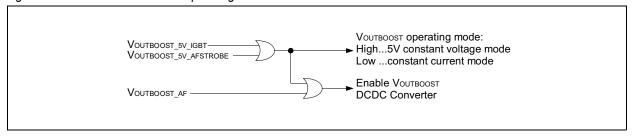


If the AF LED on pin VLED is switched on (as shown in Figure 7, by setting the pin TORCH=H or with the register bit AF and AFSTROBE) the current through the LED is defined by Max\_LED\_current (for TORCH=H) and AF\_LED\_current (for AF and AFSTROBE); if PWM=1, then the AF\_LED\_current current is PWM modulated with a duty cycle defined by AF\_LED\_PWM.

#### **DCDC Boost Converter VOUTBOOST**

VOUTBOOST is used for the IGBT driver and for the autofocus (AF) LED. Therefore it supports 5V constant voltage output and a constant current mode (where the 5V voltage output has priority) as shown in Figure 8:

Figure 8. DCDC Boost converter operating modes



<sup>5.</sup> Interrupt Status Register is only reset if STDBY is set by the interface

<sup>6.</sup> Using the internal signal Voutboost\_sv\_AFSTROBE - see DCDC Boost Converter VOUTBOOST

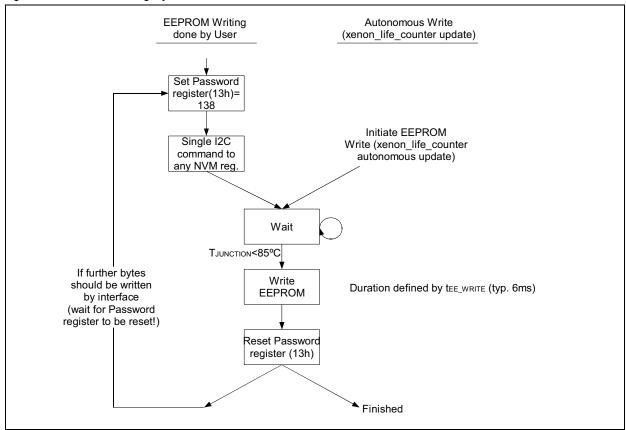


#### **EEPROM Writing Cycle**

The internal EEPROM is updated under the following two conditions:

- 1. Life Time Counter: The automatic procedure for update of the internal life time counter is shown in Figure 9; the update of the xenon\_life\_counter\_MSB (see page 28) and xenon\_life\_counter\_LSB is done every 2nd flash cycle (see Figure 5 on page 10) increasing the value by one<sup>7</sup>. The counter does not run over 0xFFFFh.
- 2. NVM Register update: Any update to a NVM register<sup>8</sup> (See Register Map on page 35) through the interface has to be started by writing 138d to the Password\_register. Then the NVM can be written. Do not read or write NVM register during the life time counter is updated. If further bytes should be written, the user shall wait until the Password\_register is reset by the AS3636 as shown in Figure 9<sup>9</sup>.

Figure 9. EEPROM Writing Cycle



If the junction temperature exceeds  $85^{\circ}$ C, the EEPROM writing is postponed until the internal temperature drops (An  $I^{2}$ C read to this register will return the old value during this time). Then the writing cycle is automatically executed. See austriamicrosystems application note 'AN3636\_In-Production\_Trimming\_xvx.pdf' for a detailed description of the trimming parameters and procedure.

Allow minimum 48ms between updates of the xenon life time counter. Updates happen every 2nd flash pulse.

<sup>8.</sup> The xenon life time counter (xenon life counter MSB and xenon life counter LSB) cannot be changed.

<sup>9.</sup> Do not initiate an EEPROM writing cycle during flash as this might collide with the xenon life time counter update.

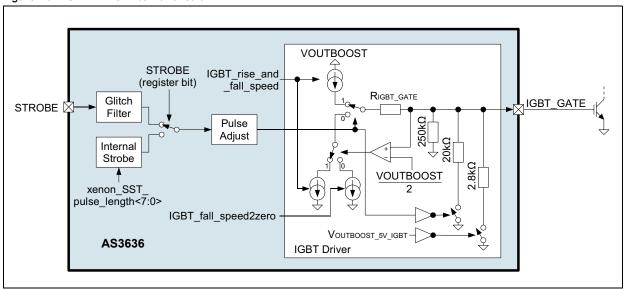


### **IGBT Driver**

The IGBT Driver shown in Figure 10 has an internal glitch filter to filter out short spikes with a length of up to tstrobe\_Min. After this filter, the strobe pulse can be adjusted in timing (see IGBT Pulse Timing adjustment on page 14). The actual IGBT driver consists of three current source. One is connected to VOUTBOOST to driver the IGBT\_GATE high. The two other current sources drive the IGBT\_GATE low, where the falling edge is divided into two sections:

- 1. IGBT rise and fall speed control the edge from VOUTBOOST to VOUTBOOST/2
- 2. IGBT\_fall\_speed2zero control the remaining part from VOUTBOOST/2 to GND.

Figure 10. IGBT Driver internal circuit



If the STROBE pulse is longer than 2ms, a timeout timer fault is raised and the strobe pulse is stopped - see Xenon charger and strobe timeout fault (TOF) on page 19.

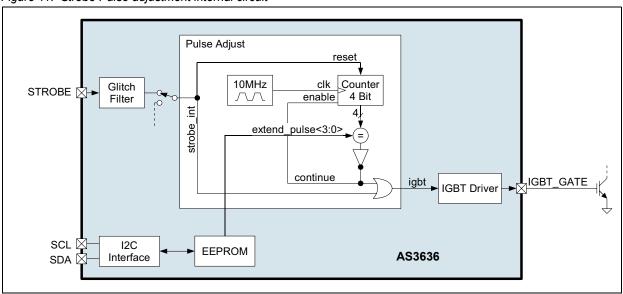
#### **IGBT Pulse Timing adjustment**

The IGBT pulse timing can be extended by a programmable duration to allow the fine adjustment of the light output from the Xenon tube during flash especially for light pulses with very short time typically used for pre-flash pulses (typically about 5µs). This adjustment can be performed on a module by module basis thus accurately trimming the light output energy over production for pre-flash pulses.

The internal circuit for this pulse adjustment is shown in Figure 11:

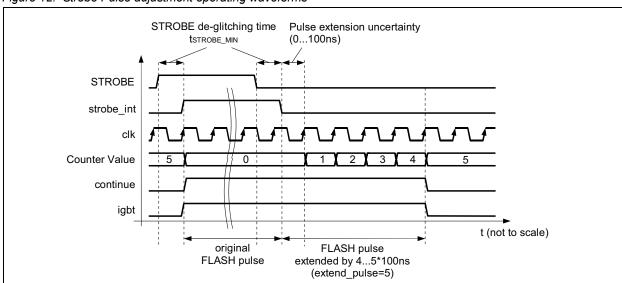


Figure 11. Strobe Pulse adjustment internal circuit



The circuit operates as shown in Figure 12:

Figure 12. Strobe Pulse adjustment operating waveforms



**Note:** As the internal oscillator is used for pulse adjustment, which is asynchronous to the external signal from STROBE, there is an uncertainty of one clock period in the actual timing extension.

If extend\_pulse (see page 29)=0, the pulse adjust circuit is disabled.



#### **Photosensor Detection circuit**

The AS3636 supports an external photosensor to detect the reflected light from the Xenon flash. If the reflected light reaches a configurable threshold, the flash pulse is stopped (IGBT\_GATE=0). Figure 13 shows the application circuit.

Figure 13. Photosensor detection circuit

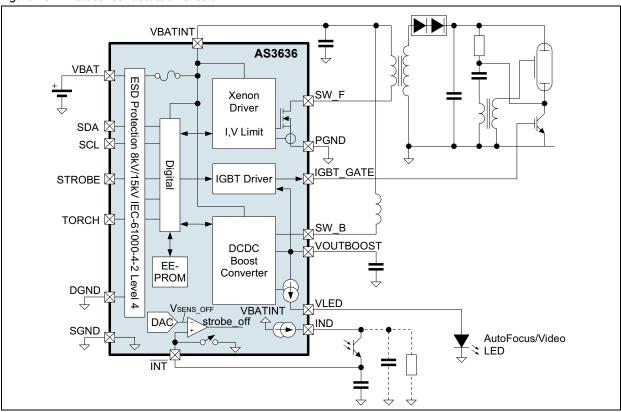
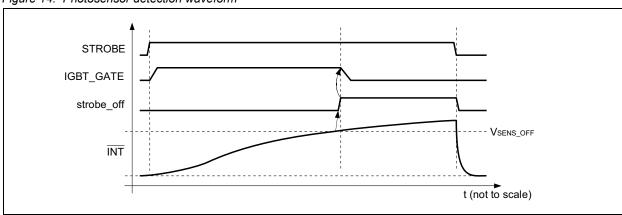


Figure 14 shows a typical waveform:

Figure 14. Photosensor detection waveform



The photosensor detection circuit is enabled by setting phsens\_on=1 (this also disables the indicator LED fault detection ILF). Set Interrupt Mask Register=0 to disable the interrupt logic <sup>10</sup>. The indicator LED current source is used to power the photosensor and can be enabled by setting IND=1, ILP=1 and IND\_LED\_current=11b. The detection threshold VSENS\_OFF is adjustable by register vsens\_off\_voltage from 1.1V to 1.7V.

<sup>10.</sup> The pin  $\overline{\text{INT}}$  is re-used for the photo-sensor input.



## **Self Testing**

The AS3636 supports internal self testing to allow the verification of the device together with all its external components in a completed system.

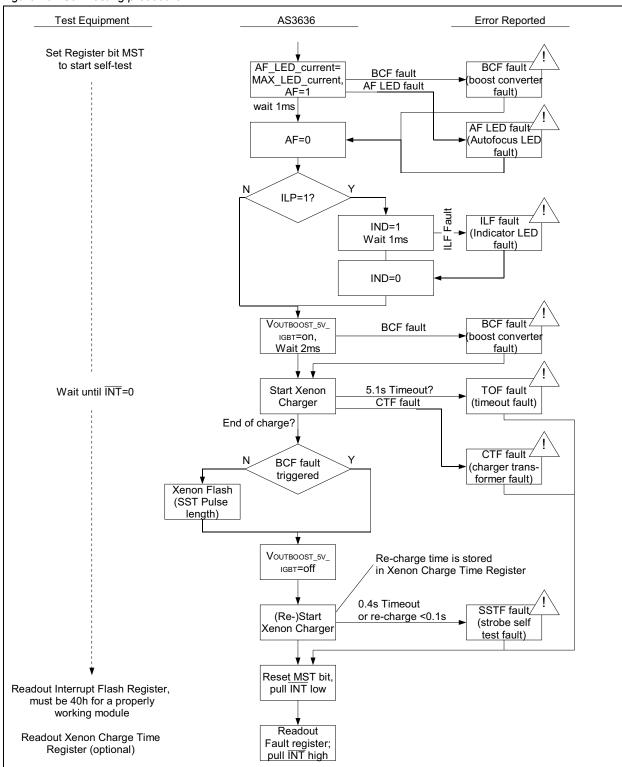
Self testing is initiated in active mode<sup>11</sup> by setting the register bit MST (see page 24) and it executes the flow described in Figure 15<sup>12</sup>. After the INT signal is low, the test equipment can readout the fault register - for a properly working module, it will read 40h (only register bit READYF set).

<sup>11.</sup> For entering active mode see Figure 5, "AS3636 operating mode," on page 10 (e.g. after charging)

<sup>12.</sup>A running self test can only be stopped by writing MST=0 and afterwards STDBY=0; the last step in the procedure is still exectued.



Figure 15. Self Testing procedure





#### **Protection and Fault Detection Functions**

The protection functions protect the AS3636 and the external devices against physical damage. In case of a failure a register bit is set. The fault bits are cleared by a readout of the Interrupt Status Register (see page 35). If enabled by the Interrupt Mask Register (see page 35), any fault condition will raise an interrupt by pulling INT low. The interrupt output INT return to open drain, once the fault condition is cleared.

#### Indicator LED fault (ILF)

If the indicator LED is enabled, an indicator LED fault is triggered under the following conditions:

- 1. In case of no or a broken LED and the current through pin IND is below IND\_OUTOPEN.
- 2. If the LED is shorted and the voltage on IND does not reach VINDSHORT.

If one of these conditions is detected the bit ILF is set but the current source is not disabled <sup>14</sup>.

#### **Charge transformer fault (CTF)**

If the Xenon charger is started and the AS3636 detects a too low inductance <sup>15</sup> of the transformer, the Xenon is stopped and the bit CTF is set.

#### Boost converter fault (BCF)

To limit the maximum current from the battery, the DCDC converter limits its current through the coil to ILIMIT. If within a single cycle ILIMIT is reached and afterwards (still in the same cycle) the current through the coil reaches zero, a shorted coil is assumed. If this condition is detected, the DCDC is stopped, the current source is disabled (if enabled) and the bit BCF is set.

#### Xenon charger and strobe timeout fault (TOF)

During every charging of the Xenon capacitor, the register charge\_time monitor the charge time. If the register reaches FFh, the Xenon charger is stopped and the bit TOF is set.

The register TOF is also set, if the strobe length (from pin STROBE) exceeds 2ms<sup>16</sup>. In this case, the IGBT\_GATE is switched off automatically.

#### Overtemperature fault (OTPF)

If the AS3636 junction temperature exceeds TOVTEMP the register bit OTPF is set. The bit OTPF is automatically reset, once the junction temperature drops below TOVTEMP-TOVTEMPHYST.

#### Autofocus LED fault (AFF)

If the autofocus LED (pin VLED) is enabled, an autofocus LED fault is triggered under the following conditions:

- 1. If the LED is shorted and the voltage on VLED does not reach VVLEDSHORT.
- 2. If the voltage on VLED stays below VVLEDOPEN.

If one of these conditions is detected, the DCDC converter is stopped, the current source is disabled and the bit AFF is set.

#### Xenon strobe self test fault (SSTF)

The xenon strobe is only used upon self testing - for details see section Self Testing on page 17. The fault bit is set if the re-charge time for the Xenon charger is above 0.4s or below 0.1s.

#### **Supply undervoltage Protection**

If the voltage on the pin VBATINT (=battery voltage) is or falls below VuvLo, the AS3636 is kept in shutdown state and all registers are set to their default state.

<sup>13.</sup>Except overtemperature protection fault OTPF.

<sup>14.</sup> To avoid erroneously disabling of the indicator current source due to short voltage drops on the supply.

<sup>15.</sup>An inductance below  $0.5\mu H$  will be detected as a fault. Above  $3.5\mu H$ , a valid transformer is detected.

<sup>16.</sup> The exact duration can vary between 930 µs to 2.15 ms.



#### I<sup>2</sup>C Serial Data Bus

The AS3636 supports the I<sup>2</sup>C bus protocol. A device that sends data onto the bus is defined as a transmitter and a device receiving data as a receiver. The device that controls the message is called a master. The devices that are controlled by the master are referred to as slaves. A master device that generates the serial clock (SCL), controls the bus access, and generates the START and STOP conditions must control the bus. The AS3636 operates as a slave on the I<sup>2</sup>C bus. Within the bus specifications a standard mode (100kHz maximum clock rate) and a fast mode (400kHz maximum clock rate) are defined. The AS3636 works in both modes. Connections to the bus are made through the open-drain I/O lines SDA and SCL.

The following bus protocol has been defined (Figure 16):

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is HIGH are interpreted as control signals.

Accordingly, the following bus conditions have been defined:

#### **Bus Not Busy**

Both data and clock lines remain HIGH.

#### Start Data Transfer

A change in the state of the data line, from HIGH to LOW, while the clock is HIGH, defines a START condition.

#### Stop Data Transfer

A change in the state of the data line, from LOW to HIGH, while the clock line is HIGH, defines the STOP condition.

#### Data Valid

The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal. The data on the line must be changed during the LOW period of the clock signal. There is one clock pulse per bit of data.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of data bytes transferred between START and STOP conditions are not limited, and are determined by the master device. The information is transferred byte-wise and each receiver acknowledges with a ninth bit.

#### Acknowledge

Each receiving device, when addressed, is obliged to generate an acknowledge after the reception of each byte. The master device must generate an extra clock pulse that is associated with this acknowledge bit.

A device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge-related clock pulse. Of course, setup and hold times must be taken into account. A master must signal an end of data to the slave by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave must leave the data line HIGH to enable the master to generate the STOP condition.



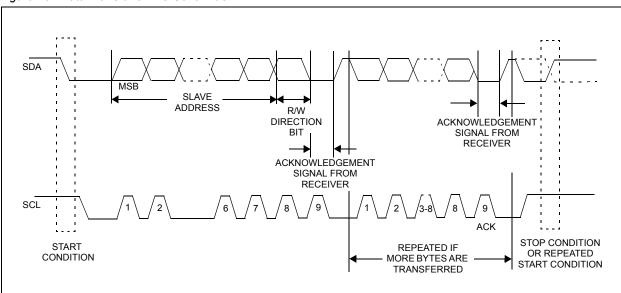


Figure 16. Data Transfer on I<sup>2</sup>C Serial Bus

Depending upon the state of the R/W bit, two types of data transfer are possible:

- 1. **Data transfer from a master transmitter to a slave receiver.** The first byte transmitted by the master is the slave address. Next follows a number of data bytes. The slave returns an acknowledge bit after each received byte. Data is transferred with the most significant bit (MSB) first.
- 2. Data transfer from a slave transmitter to a master receiver. The master transmits the first byte (the slave address). The slave then returns an acknowledge bit, followed by the slave transmitting a number of data bytes. The master returns an acknowledge bit after all received bytes other than the last byte. At the end of the last received byte, a "not acknowledge" is returned. The master device generates all of the serial clock pulses and the START and STOP conditions. A transfer is ended with a STOP condition or with a repeated START condition. Since a repeated START condition is also the beginning of the next serial transfer, the bus is not released. Data is transferred with the most significant bit (MSB) first.

The AS3636 can operate in the following two modes:

- 1. Slave Receiver Mode (Write Mode): Serial data and clock are received through SDA and SCL. After each byte is received an acknowledge bit is transmitted. START and STOP conditions are recognized as the beginning and end of a serial transfer. Address recognition is performed by hardware after reception of the slave address and direction bit (see Figure 17). The slave address byte is the first byte received after the master generates the START condition. The slave address byte contains the 7-bit AS3636 address, which is 0101000, followed by the direction bit (R/W), which, for a write, is 0. <sup>17</sup> After receiving and decoding the slave address byte the device outputs an acknowledge on the SDA line. After the AS3636 acknowledges the slave address + write bit, the master transmits a register address to the AS3636. This sets the register pointer on the AS3636. The master may then transmit zero or more bytes of data, with the AS3636 acknowledging each byte received. The address pointer will increment after each data byte is transferred. The master generates a STOP condition to terminate the data write.
- 2. Slave Transmitter Mode (Read Mode): The first byte is received and handled as in the slave receiver mode. However, in this mode, the direction bit indicates that the transfer direction is reversed. Serial data is transmitted on SDA by the AS3636 while the serial clock is input on SCL. START and STOP conditions are recognized as the beginning and end of a serial transfer (Figure 18 and Figure 19). The slave address byte is the first byte received after the master generates a START condition. The slave address byte contains the 7-bit AS3636 address, which is 0101000, followed by the direction bit (R/W), which, for a read, is 1. After receiving and decoding the slave address byte the device outputs an acknowledge on the SDA line. The AS3636 then begins to transmit data starting with the register address pointed to by the register pointer. If the register

<sup>17.</sup> The address for writing to the AS3636 is 50h = 01010000b

<sup>18.</sup> The address for read mode from the AS3636 is 51h = 01010001b



pointer is not written to before the initiation of a read mode the first address that is read is the last one stored in the register pointer. The AS3636 must receive a "not acknowledge" to end a read.

Figure 17. Data Write - Slave Receiver Mode

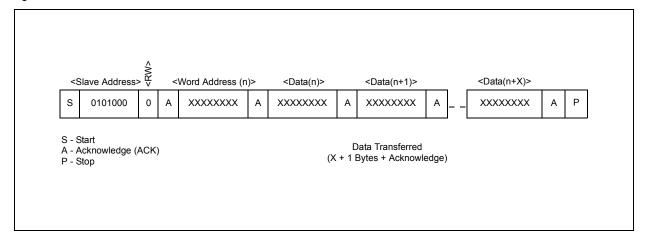


Figure 18. Data Read (from Current Pointer Location) - Slave Transmitter Mode

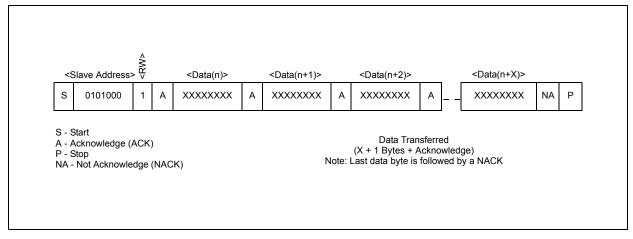
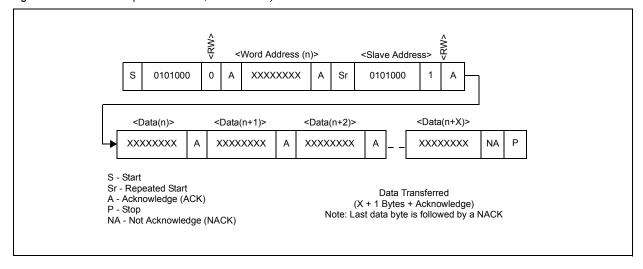


Figure 19. Data Read (Write Pointer, Then Read) - Slave Receive and Transmit





## **Register Description**

Table 4. IC Info Register

| Addr: 00h |                    | IC Info Register   |                            |                       |  |  |  |
|-----------|--------------------|--|----------------------------|-----------------------|--|--|--|
|           |                    | This register has a fixed content and can be used to verify the I <sup>2</sup> C communication |                            |                       |  |  |  |
| Bit       | Bit Name           | Default  | Default Access Description |                       |  |  |  |
| 3:0       | IC_model           | 0010b  | R                          | Fixed ID              |  |  |  |
| 7:4       | IC_manufacturer_ID | 0001b  | R                          | Fixed Manufacturer ID |  |  |  |

Table 5. IC Version Control Register

| Addr: 01h |              |                             | IC Version Control Register |  |  |  |  |  |
|-----------|--------------|-----------------------------|-----------------------------|--|--|--|--|--|
|           |              | Design Round Identification |                             |  |  |  |  |  |
| Bit       | Bit Name     | Default                     | Access                      | Description                            |  |  |  |  |
| 3:0       | Design_round | NA                          | R                           | Internal number; don't use in software |  |  |  |  |
| 7:4       |              | 0h                          | R                           | always 0, don't use                    |  |  |  |  |

Table 6. Module Info Reg.A

|     | Addr: 02h              |         | Module Info Reg.A                                      |                   |                     |                   |  |  |
|-----|------------------------|---------|--|-------------------|---------------------|-------------------|--|--|
|     |                        |         | Module identification - written by module manufacturer |                   |                     |                   |  |  |
| Bit | Bit Name               | Default | Access   | Description       |                     |                   |  |  |
|     |                        |         |  |                   | Module Sample Type  |                   |  |  |
|     |                        |         |  | 00                | Technology Sample   |                   |  |  |
| 1:0 | Module_Type            | NVM     | R  | 01                | Engineering Sample  |                   |  |  |
|     |                        |         |  |                   | 10                  | Commercial Sample |  |  |
|     |                        |         |  | 11                | Mass Production     |                   |  |  |
| 4:2 | Module_Generation      | NVM     | R  | Module Generation |                     |                   |  |  |
| 7:5 | Module_Manufacturer_ID | NVM     | R  |                   | Module Manufacturer |                   |  |  |

Table 7. Module Info Register B

| Addr: 03h |                       | Module Info Register B |  |                                  |  |  |  |  |
|-----------|-----------------------|------------------------|--|----------------------------------|--|--|--|--|
|           |                       |                        | Module identification - written by module manufacturer |                                  |  |  |  |  |
| Bit       | Bit Name              | Default                | Access   | Description                      |  |  |  |  |
| 3:0       | Module_Major_Version  | NVM                    | R  | Module Manufacturer Version      |  |  |  |  |
| 7:4       | Module_Project_Number | NVM                    | R  | Module Manufacturer Project Code |  |  |  |  |



Table 8. Control Register

|     | Addm: O4b  |         |   |     | Control Register   |  |  |   |   |   |
|-----|------------|---------|---|-----|--|--|--|---|---|---|
|     | Addr: 04h  |         |   |     | Operating mode of AS3636   |  |  |   |   |   |
| Bit | Bit Name   | Default | Access                                  |     | Description  |  |  |   |   |   |
|     |            |         |   |     | Watchdog timer enable  |  |  |   |   |   |
|     |            |         |   | 0   | No watchdog timer  |  |  |   |   |   |
| 0   | 0 WATCHDOG | 1       | R/W                                     | 1   | After one minute after charging is finished the AS3636 automatically enters standby mode; any read or write access to any AS3636 register resets this one minute watchdog timer      |  |  |   |   |   |
|     |            |         |   |     | Strobe input usage (level sensitive)   |  |  |   |   |   |
| 1   | AFSTROBE   | 0       | R/W                                     | 0   | STROBE input is used for Xenon flash   |  |  |   |   |   |
|     |            |         |   | 1   | STROBE input is used for AF LED on/off; LED current is defined by LED Current Register with no PWM   |  |  |   |   |   |
|     |            |         |   |     | Module Self Testing  |  |  |   |   |   |
| 2   | 2 MST      | 0       | R/W                                     | R/W | 0  | Read: No module test running<br>Write: Writing '0' stops a running self test   |  |   |   |   |
|     |            |         |   |     | 1  | Writing '1' to this register starts the module self test procedure; when the test is finished MST is automatically cleared - see Self Testing on page 17 |  |   |   |   |
|     |            |         | R                                       | R   | R  |  | TORCH pin status (used for module testing) |   |   |   |
| 3   | TORCH_S    | 0       |   |     |  | R  | R  | R | R   | R |
|     |            |         |   | 1   | high   |  |  |   |   |   |
| 5:4 |            | 00b     | R                                       |     | always 0, don't use  |  |  |   |   |   |
|     |            |         |   |     | Reset of all registers   |  |  |   |   |   |
| 6   | RESET      | 0       | R                                       |     | always reads back '0'  |  |  |   |   |   |
| 0   | 112021     |         | W                                       | 0   | no action  |  |  |   |   |   |
|     |            |         | • | 1   | all registers are reset to their default   |  |  |   |   |   |
|     |            |         |   |     | Standby mode   |  |  |   |   |   |
|     |            |         | R/W                                     |     |  |  |  | 0 | normal operation (all modes are possible) |   |
| 7   | STDBY      | 0       |   | 1   | Writing '1' writes defaults to Xenon Control Register,<br>LED Control Register and eventually to the Control<br>Register. The AS3636 enters standby mode and<br>clears the bit STDBY |  |  |   |   |   |

Table 9. Interrupt Mask Register

| Addr: 05h |          | Interrupt Mask Register |  |             |   |   |         |
|-----------|----------|-------------------------|--|-------------|---|---|---------|
|           |          | M                       | Mask Interrupts (interrupt output INT, open drain, active low) |             |   |   |         |
| Bit       | Bit Name | Default                 | Access   | Description |   |   |         |
|           |          |                         |  |             | Indicator LED fault interrupt             |   |         |
| 0         | ILFI     | 1                       | R/W  | R/W 0       | Disabled                                  |   |         |
|           |          |                         |  |             |   | 1 | Enabled |
|           |          |                         |  |             | Xenon Charger Transformer fault interrupt |   |         |
| 1         | CTFI     | 1                       | R/W  | 0           | Disabled                                  |   |         |
|           |          |                         |  | 1           | Enabled                                   |   |         |



Table 9. Interrupt Mask Register (Continued)

| Addr: 05h |            |         | Interrupt Mask Register  |         |   |  |  |  |  |
|-----------|------------|---------|--|---------|---|--|--|--|--|
|           | Addi. 0311 |         | Mask Interrupts (interrupt output INT, open drain, active low) |         |   |  |  |  |  |
| Bit       | Bit Name   | Default | Access   |         | Description                                     |  |  |  |  |
|           |            |         |  | DC      | CDC Boost converter (VOUTBOOST) fault interrupt |  |  |  |  |
| 2         | BCFI       | 1       | R/W  | 0       | Disabled  |  |  |  |  |
|           |            |         |  | 1       | Enabled   |  |  |  |  |
|           |            |         |  | ·       | Xenon Charger Timeout fault interrupt           |  |  |  |  |
| 3         | TOFI       | 1       | R/W  | 0       | Disabled  |  |  |  |  |
|           |            |         | 1  | Enabled |   |  |  |  |  |
|           |            | OTPFI 1 | R/W  | ·       | Over Temperature protection fault interrupt     |  |  |  |  |
| 4         | OTPFI      |         |  | 0       | Disabled  |  |  |  |  |
|           |            |         |  | 1       | Enabled   |  |  |  |  |
|           |            |         |  | ·       | Autofocus LED (VLED) fault interrupt            |  |  |  |  |
| 5         | AFFI       | 1       | R/W  | 0       | Disabled  |  |  |  |  |
|           |            |         |  | 1       | Enabled   |  |  |  |  |
|           |            |         |  |         | Xenon charger ready interrupt                   |  |  |  |  |
| 6         | READYFI    | 1       | R/W  | 0       | Disabled  |  |  |  |  |
|           |            |         |  | 1       | Enabled   |  |  |  |  |
|           |            |         |  |         | Xenon Strobe Self test fault interrupt          |  |  |  |  |
| 7         | SSTFI      | 1       | R/W  | 0       | Disabled  |  |  |  |  |
|           |            |         |  | 1       | Enabled   |  |  |  |  |

Table 10. Interrupt Status Register

|     |           | Interrupt Status Register |  |   |   |  |  |
|-----|-----------|---------------------------|--|---|---|--|--|
|     | Addr: 06h |                           | Interrupts status (interrupt output $\overline{\text{INT}}$ , open drain, active low); reading this register automatically clears the interrupt; see Protection and Fault Detection Functions on page 19 |   |   |  |  |
| Bit | Bit Name  | Default                   | Access   |   | Description                                     |  |  |
|     |           |                           |  |   | Indicator LED fault interrupt                   |  |  |
| 0   | ILF       | 0                         | R/SC <sup>1</sup>  | 0 | no interrupt                                    |  |  |
|     |           |                           |  | 1 | interrupt occurred                              |  |  |
|     |           | 0                         | R/SC <sup>1</sup>  |   | Xenon Charger Transformer fault interrupt       |  |  |
| 1   | CTF       |                           |  | 0 | no interrupt                                    |  |  |
|     |           |                           |  | 1 | interrupt occurred                              |  |  |
|     |           |                           |  | D | CDC Boost converter (VOUTBOOST) fault interrupt |  |  |
| 2   | BCF       | 0                         | R/SC <sup>1</sup>  | 0 | no interrupt                                    |  |  |
|     |           |                           |  | 1 | interrupt occurred                              |  |  |
|     |           | 0                         |  |   | Xenon Charger or Strobe Timeout fault interrupt |  |  |
| 3   | TOF       |                           | R/SC <sup>1</sup>  | 0 | no interrupt                                    |  |  |
|     |           |                           |  | 1 | interrupt occurred                              |  |  |



Table 10. Interrupt Status Register (Continued)

|     |           | Interrupt Status Register |  |   |  |  |  |
|-----|-----------|---------------------------|--|---|--|--|--|
|     | Addr: 06h |                           | Interrupts status (interrupt output $\overline{\text{INT}}$ , open drain, active low); reading this register automatically clears the interrupt; see Protection and Fault Detection Functions on page 19 |   |  |  |  |
| Bit | Bit Name  | Default                   | Access   | Description                                 |  |  |  |
|     |           |                           |  | Over Temperature protection fault interrupt |  |  |  |
| 4   | OTPF      | 0                         | R/SC <sup>1</sup>  | 0 no interrupt                              |  |  |  |
|     |           |                           |  | 1 interrupt occurred                        |  |  |  |
|     |           |                           |  | Autofocus LED (VLED) fault interrupt        |  |  |  |
| 5   | AFF       | 0                         | R/SC <sup>1</sup>  | 0 no interrupt                              |  |  |  |
|     |           |                           |  | 1 interrupt occurred                        |  |  |  |
|     |           |                           |  | Xenon charger ready interrupt flag          |  |  |  |
| 6   | READYF    | 0                         | R/SC <sup>1</sup>  | 0 no interrupt                              |  |  |  |
|     |           |                           |  | 1 interrupt occurred                        |  |  |  |
|     |           |                           | Xenon Strobe Self test fault interrupt   |   |  |  |  |
| 7   | SSTF      | 0 R/S                     | R/SC <sup>1</sup>  | 0 no interrupt                              |  |  |  |
|     |           |                           |  | 1 interrupt occurred                        |  |  |  |

<sup>1.</sup> R/SC = Read, self clear: Upon readout, the register bit is automatically cleared.

Table 11. Xenon Control Register

| Addr: 07h |            | Xenon Control Register |                                       |   |  |  |  |  |
|-----------|------------|------------------------|---------------------------------------|---|--|--|--|--|
|           | Addr. 0711 |                        | Control Xenon Charger and Re-charging |   |  |  |  |  |
| Bit       | Bit Name   | Default                | Access                                |   | Description  |  |  |  |
|           |            |                        |                                       |   | Xenon charging   |  |  |  |
| 0         | CHARGE     | 0                      | R/W                                   | 0 | Read: no charging;<br>Write: writing '0' to CHARGE stops charging                  |  |  |  |
|           |            |                        |                                       | 1 | Read: Xenon charger running;<br>Write: writing '1' to CHARGE starts charging       |  |  |  |
|           | READY      | 0                      | R                                     |   | Xenon Charger Finished charging  |  |  |  |
| 1         |            |                        |                                       | 0 | not ready for flash  |  |  |  |
|           |            |                        |                                       | 1 | ready for flash; a flash strobe automatically resets READY                         |  |  |  |
|           |            |                        |                                       |   | Strobe test pulse enable   |  |  |  |
|           |            | 0                      | R                                     | 0 | Input pin STROBE <sup>1</sup> =0   |  |  |  |
| 2         | STROBE     |                        |                                       | 1 | Input pin STROBE <sup>1</sup> =1   |  |  |  |
|           |            |                        |                                       | 0 | IGBT strobe flash is controlled by STROBE pin                                      |  |  |  |
|           |            |                        | W                                     | 1 | A Xenon flash test pulse of length Xenon SST Pulse<br>Length Register is generated |  |  |  |



Table 11. Xenon Control Register (Continued)

| A .d 07b |           | Xenon Control Register |                                       |                     |  |  |  |  |
|----------|-----------|------------------------|---------------------------------------|---------------------|--|--|--|--|
|          | Addr: 07h |                        | Control Xenon Charger and Re-charging |                     |  |  |  |  |
| Bit      | Bit Name  | Default                | Access Description                    |                     | Description  |  |  |  |
|          |           | 0                      | R/W                                   |                     | Xenon Charger automatic recharge                     |  |  |  |
| 3        | CAR       |                        |                                       | 0                   | no automatic recharge                                |  |  |  |
|          | -         |                        |                                       | 1                   | automatic recharge enabled - see Figure 5 on page 10 |  |  |  |
| 7:4      |           | 0000b                  | R                                     | always 0, don't use |  |  |  |  |

<sup>1.</sup> Reading register bit STROBE only returns valid results, if Voutboost\_5v\_IGBT or Voutboost\_5v\_AFSTROBE is set. Voutboost\_5v\_IGBT is set during or after Xenon charging (see Figure 6 on page 11), Voutboost\_5v\_AFSTROBE is set if AFSTROBE is set (see Figure 7 on page 12).

Table 12. Xenon CAR Interval Register

|     | Addr: 08h                 |         | Xenon CAR Interval Register       |     |  |  |  |
|-----|---------------------------|---------|-----------------------------------|-----|--|--|--|
|     |                           |         | Xenon automatic Re-charging Timer |     |  |  |  |
| Bit | Bit Name                  | Default | efault Access Description         |     |  |  |  |
|     |                           |         |                                   | Χe  | enon Re-charging Timer see Figure 5 on page 10 |  |  |
|     |                           |         |                                   | 000 | 1.0s   |  |  |
|     |                           |         |                                   | 001 | default<br>1.5s                                |  |  |
|     |                           |         |                                   | 010 | 2.0s   |  |  |
| 2:0 | CAR_interval <sup>1</sup> | 001b    | R/W                               | 011 | 2.5s   |  |  |
|     |                           |         |                                   | 100 | 3.0s   |  |  |
|     |                           |         |                                   | 101 | 3.5s   |  |  |
|     |                           |         |                                   | 110 | 4.0s   |  |  |
|     |                           |         |                                   | 111 | 4.5s   |  |  |
| 7:3 |                           | 00h     | R                                 |     | always 0, don't use                            |  |  |

<sup>1.</sup> The first recharge interval can be shorter than selected due to an synchronization to an internal timer. The recharge time is always measured from start of recharge to the next start of recharge.



Table 13. Xenon Charge Time Register

|     | Addr: 09h   |         | Xenon Charge Time Register       |  |   |  |  |  |
|-----|-------------|---------|----------------------------------|--|---|--|--|--|
|     |             |         | Measure last xenon charging time |  |   |  |  |  |
| Bit | Bit Name    | Default | fault Access Description         |  |   |  |  |  |
|     |             |         | Xen                              | on charging time; register content is valid if READY=1 |   |  |  |  |
|     |             |         |                                  | 00h  | 0-20ms  |  |  |  |
|     |             |         |                                  | 01h  | 20-40ms   |  |  |  |
|     |             |         |                                  | 02h  | 40ms-60ms   |  |  |  |
| 7:0 | charge_time | 00h     | R                                | 03h  | 60ms-80ms   |  |  |  |
|     |             |         |                                  |  |   |  |  |  |
|     |             |         |                                  | FEh  | 5080-5100ms   |  |  |  |
|     |             |         |                                  | FFh  | >5100ms<br>Xenon charger time out fault was triggered - see TOF |  |  |  |

Table 14. Xenon SST Pulse Length Register

|     | Addr: 0Ah                                |                            | Xenon SST Pulse Length Register |     |  |  |  |  |
|-----|--|----------------------------|---------------------------------|-----|--|--|--|--|
|     |  |                            | Xenon strobe test pulse length  |     |  |  |  |  |
| Bit | Bit Name                                 | Default Access Description |                                 |     |  |  |  |  |
|     |  | NVM                        | R                               | STF | define Xenon strobe pulse length for register bit ROBE=1 and for Xenon module self testing - see Self Testing on page 17 |  |  |  |
|     | vernen SST nulse lengt                   |                            |                                 | 00h | don't use  |  |  |  |
| 7:0 | xernon_SST_pulse_lengt<br>h <sup>1</sup> |                            |                                 | 01h | 1μs  |  |  |  |
|     |  |                            |                                 | 02h | 2μs  |  |  |  |
|     |  |                            |                                 |     |  |  |  |  |
|     |  |                            |                                 | FFh | 255µs  |  |  |  |

<sup>1.</sup> The resulting timing can vary by  $+1\mu s$ /-0 $\mu$ s (excluding the variation of the internal oscillator), therefore use this internal pulse generator only for self testing.

Table 15. Xenon Life Time Register MSB

|  | Addr: 0Bh |                        | Xenon Life Time Register MSB |        |  |  |  |  |
|--|-----------|------------------------|------------------------------|--------|--|--|--|--|
|  |           |                        | xenon_life_counter_MSB       |        |  |  |  |  |
|  | Bit       | Bit Name               | Default                      | Access | Description  |  |  |  |
|  | 7:0       | xenon_life_counter_MSB | NVM                          | R      | Count the number of flash double-pulses performed and store in NVM - see AS3636 operating mode on page 10 counter stops at FFFFh |  |  |  |

Table 16. Xenon Life Time Register LSB

|  | Addr: 0Ch |                        | Xenon Life Time Register LSB |        |  |  |  |  |
|--|-----------|------------------------|------------------------------|--------|--|--|--|--|
|  |           |                        | xenon_life_counter_LSB       |        |  |  |  |  |
|  | Bit       | Bit Name               | Default                      | Access | Description  |  |  |  |
|  | 7:0       | xenon_life_counter_LSB | NVM                          | R      | Count the number of flash double-pulses performed and store in NVM - see AS3636 operating mode on page 10 counter stops at FFFFh |  |  |  |



Table 17. Xenon Config Register A

|     | Addr: 0Dh                |         | Xenon Config Register A   |     |                     |  |  |  |
|-----|--------------------------|---------|---|-----|---------------------|--|--|--|
|     |                          |         | Define the end of charge detection voltage                              |     |                     |  |  |  |
| Bit | Bit Name                 | Default | Default Access Description  |     |                     |  |  |  |
|     |                          |         | Define the Xenon end of charge detection voltage (measured on pin SW_F) |     |                     |  |  |  |
|     |                          | NVM     | R   | 00h | 28.5V               |  |  |  |
| 5:0 | charge_voltage_selection |         |   | 01h | 28.6V               |  |  |  |
|     | 0 _ 0 _                  |         |   | 02h | 28.7V               |  |  |  |
|     |                          |         |   |     |                     |  |  |  |
|     |                          |         |   | 3Fh | 34.8V               |  |  |  |
| 7:6 |                          | 00b     | R   |     | always 0, don't use |  |  |  |

Table 18. Xenon Config Register B

|     | Addr: 0Eh                             |         | Xenon Config Register B                             |       |   |  |  |
|-----|---------------------------------------|---------|---|-------|---|--|--|
|     |                                       |         | Define the peak current limit for the Xenon charger |       |   |  |  |
| Bit | Bit Name                              | Default | Access  |       | Description   |  |  |
|     |                                       |         |   |       | Peak current limit measured on pin SW_F   |  |  |
|     |                                       |         |   | 000   | 375mA   |  |  |
|     |                                       |         |   | 001   | 450mA   |  |  |
|     |                                       |         |   | 010   | 525mA   |  |  |
| 2:0 | switch_current_selection <sup>1</sup> | NVM     | R   | 011   | 600mA   |  |  |
|     |                                       |         |   | 100   | 675mA   |  |  |
|     |                                       |         |   | 101   | 750mA   |  |  |
|     |                                       |         |   | 110   | 825mA   |  |  |
|     |                                       |         |   | 111   | 900mA   |  |  |
|     |                                       |         |   | Ex    | tend the timing for the IGBT strobe pulse - see IGBT Pulse Timing adjustment                          |  |  |
|     |                                       |         |   | 0h    | no pulse extension  |  |  |
|     |                                       |         |   | 1h    | 100ns   |  |  |
| 6:3 | extend_pulse                          | NVM     | R   | 2h    | 200ns   |  |  |
|     |                                       |         |   | 3h    | 300ns   |  |  |
|     |                                       |         |   |       |   |  |  |
|     |                                       |         |   | Eh    | 1400ns  |  |  |
|     |                                       |         |   | Fh    | 1500ns  |  |  |
|     |                                       | NVM     |   | Defir | ne together with IGBT_fall_speed2zero IGBT driver fall speed for final switch-off (VOUTBOOST/2 to 0V) |  |  |
| 7   | IGBT_fall2zero_slow                   |         | R/W   | 0     | full current - see IGBT_fall_speed2zero   |  |  |
|     |                                       |         |   | 1     | half current - see IGBT_fall_speed2zero   |  |  |

<sup>1.</sup> Take care to set the peak current limit to fit to the Xenon charger transformer used - if the peak current limit is set too low, efficiency will drop and eventually end of charge will not be reached anymore.



Table 19. Xenon Config Register C

|     | Addr: 0Fh                         | Xenon Config Register C |           |  |  |  |  |  |
|-----|-----------------------------------|-------------------------|-----------|--|--|--|--|--|
|     | Addr. UFII                        | De                      | fine IGBT | drive  | er parameters and SW_B switch current limits                           |  |  |  |
| Bit | Bit Name                          | Default                 | Access    | Description  |  |  |  |  |
|     |                                   |                         |           |  | Define IGBT driver fall speed for final switch-off (VOUTBOOST/2 to 0V) |  |  |  |
|     |                                   |                         |           |  | IGBT_fall2zero_slow = 0 1  |  |  |  |
|     |                                   |                         |           | 000  | 1V/μs (10mA) 0.5V/μs (5mA)   |  |  |  |
|     |                                   |                         |           | 001  | 2V/μs (20mA) 1V/μs (10mA)  |  |  |  |
| 2:0 | IGBT_fall_speed2zero <sup>1</sup> | NVM                     | R         | 010  | 3V/μs (30mA) 1.5V/μs (15mA)  |  |  |  |
|     |                                   |                         |           | 011  | 4V/μs (40mA) 2V/μs (20mA)  |  |  |  |
|     |                                   |                         |           | 100  | 5V/μs (50mA) 2.5V/μs (25mA)  |  |  |  |
|     |                                   |                         |           | 101  | 6V/µs (60mA) 3V/µs (30mA)  |  |  |  |
|     |                                   |                         |           | 110  | 7V/µs (70mA) 3.5V/µs (35mA)  |  |  |  |
|     |                                   |                         |           | 111  | 8V/µs (80mA) 4V/µs (40mA)  |  |  |  |
|     |                                   |                         |           | Define IGBT switch-on speed and switch-off down to VOUTBOOST/2 |  |  |  |  |
|     |                                   |                         |           | 000  | 1V/μs (10mA)   |  |  |  |
|     |                                   |                         |           | 001  | 2V/µs (20mA)   |  |  |  |
|     | IGBT_rise_and_fall_spee           |                         |           | 010  | 3V/μs (30mA)   |  |  |  |
| 5:3 | d <sup>2</sup>                    | NVM                     | R         | 011  | 4V/μs (40mA)   |  |  |  |
|     |                                   |                         |           | 100  | 5V/μs (50mA)   |  |  |  |
|     |                                   |                         |           | 101  | 6V/μs (60mA)   |  |  |  |
|     |                                   |                         |           | 110  | 7V/µs (70mA)   |  |  |  |
|     |                                   |                         |           | 111  | 8V/µs (80mA)   |  |  |  |
|     |                                   |                         |           | [  | DCDC Boost Coil Peak current setting (pin SW_B)                        |  |  |  |
|     |                                   |                         |           | 00   | 250mA  |  |  |  |
| 7:6 | coil_peak_current                 | NVM                     | R         | 01   | 300mA  |  |  |  |
|     |                                   |                         |           | 10   | 350mA  |  |  |  |
|     |                                   |                         |           | 11   | 400mA  |  |  |  |

<sup>1.</sup> Assuming a 10nF capacitance. The timings scale by the gate capacitance of the IGBT

<sup>2.</sup> Assuming a 10nF capacitance. The timings scale by the gate capacitance of the IGBT



Table 20. LED Current Register

|     | A -1-1 401-                 |         |        |                         | LED Current Register                  |  |  |  |
|-----|-----------------------------|---------|--------|-------------------------|---------------------------------------|--|--|--|
|     | Addr: 10h                   |         | AF LE  | and ir                  | ndicator LED current and PWM settings |  |  |  |
| Bit | Bit Name                    | Default | Access |                         | Description                           |  |  |  |
|     |                             |         |        | AF LED Current settings |                                       |  |  |  |
|     |                             |         |        | 000                     | 10mA                                  |  |  |  |
|     |                             |         |        | 001                     | 15mA                                  |  |  |  |
|     |                             |         |        | 010                     | 20mA                                  |  |  |  |
| 2:0 | AF_LED_current <sup>1</sup> | 000b    | R/W    | 011                     | 28mA                                  |  |  |  |
|     |                             |         |        | 100                     | 37mA                                  |  |  |  |
|     |                             |         |        | 101                     | 50mA                                  |  |  |  |
|     |                             |         |        | 110                     | 65mA                                  |  |  |  |
|     |                             |         |        | 111                     | 80mA                                  |  |  |  |
|     |                             |         | R/W    | ·                       | AF LED PWM setting                    |  |  |  |
|     |                             |         |        | 000                     | 1/32                                  |  |  |  |
|     |                             |         |        | 001                     | 2/32                                  |  |  |  |
|     |                             |         |        | 010                     | 3/32                                  |  |  |  |
| 5:3 | AF_LED_PWM <sup>2</sup>     | 000b    |        | 011                     | 5/32                                  |  |  |  |
|     |                             |         |        | 100                     | 8/32                                  |  |  |  |
|     |                             |         |        | 101                     | 12/32                                 |  |  |  |
|     |                             |         |        | 110                     | 20/32                                 |  |  |  |
|     |                             |         |        | 111                     | 32/32                                 |  |  |  |
|     |                             |         |        |                         | Indicator LED current setting         |  |  |  |
|     |                             |         |        | 00                      | 2mA                                   |  |  |  |
| 7:6 | IND_LED_current             | 00b     | R/W    | 01                      | 4mA                                   |  |  |  |
|     |                             |         |        | 10                      | 8mA                                   |  |  |  |
|     |                             |         |        | 11                      | 16mA                                  |  |  |  |

- 1. AF\_LED\_current setting is automatically limited to Max\_LED\_current (see page 32)
- 2. The internal PWM generator output frequency is 31.25kHz (to avoid audible noise)

Table 21. LED Control Register

|     | Addr: 11h               |         | LED Control Register                            |   |     |  |  |  |  |
|-----|-------------------------|---------|---|---|-----|--|--|--|--|
|     | Addi. Tili              |         | Control AF LED and indicator LED operating mode |   |     |  |  |  |  |
| Bit | Bit Name                | Default | Access  | Description   |     |  |  |  |  |
|     |                         |         |   | Indicator LED on/off  |     |  |  |  |  |
|     |                         |         |   | 0   | off |  |  |  |  |
| 0   | 0 IND <sup>1</sup> 0 RA | R/W     | 1   | if ILP=0: use VLED output with AF_LED_current and AF_LED_PWM duty cycle |     |  |  |  |  |
|     |                         |         |   | if ILP=1: use IND output with IND_LED_current                           |     |  |  |  |  |



Table 21. LED Control Register (Continued)

|     | A alalas 44 la    | LED Control Register                            |        |     |  |  |  |  |
|-----|-------------------|---|--------|-----|--|--|--|--|
|     | Addr: 11h         | Control AF LED and indicator LED operating mode |        |     |  |  |  |  |
| Bit | Bit Name          | Default   | Access |     | Description  |  |  |  |
|     |                   |   |        |     | 100ms Indicator LED pulse  |  |  |  |
|     |                   |   | R/W    | 0   | no pulse   |  |  |  |
| 1   | INDP <sup>2</sup> | 0   |        | R/W | 1  | if ILP=0: 100ms pulse on VLED output with AF_LED_current and AF_LED_PWM duty cycle |  |  |
|     |                   |   |        | '   | if ILP=1: 100ms pulse on IND output with IND_LED_current               |  |  |  |
|     |                   |   |        |     | AF LED PWM enable if AF=1(pin VLED)                                    |  |  |  |
| 2   | PWM               | 0   | R/W    | 0   | no PWM   |  |  |  |
|     |                   |   |        | 1   | AF LED PWM with AF_LED_PWM   |  |  |  |
|     |                   |   |        |     | AF LED on/off (pin VLED)   |  |  |  |
| 3   | AF <sup>3</sup>   | 0   | R/W    | 0   | off  |  |  |  |
|     | 7,4               | _   |        | 1   | enabled AF LED with AF_LED_current; if PWM=1 use AF_LED_PWM duty cycle |  |  |  |
| 7:4 |                   | 0000b   | R      |     | always 0, don't use  |  |  |  |

- 1. If IND=1 and INDP=1, IND=1 has priority
- 2. After the 100ms pulse, the register INDP is automatically reset
- 3. Do not operate AF=1 and (IND or INDP=1) at the same time

Table 22. LED Configuration Register

|     | Addr: 12h       |         | LED Configuration Register                            |                              |                     |  |  |  |  |
|-----|-----------------|---------|---|------------------------------|---------------------|--|--|--|--|
|     | Addr: 1211      |         | Set maxim AF LED current and configure indicator type |                              |                     |  |  |  |  |
| Bit | Bit Name        | Default | Access  |                              | Description         |  |  |  |  |
|     |                 |         |   | AF LED Maximum current limit |                     |  |  |  |  |
|     |                 |         |   | 000                          | 10mA                |  |  |  |  |
|     |                 |         |   | 001                          | 15mA                |  |  |  |  |
|     |                 |         | 010   | 20mA                         |                     |  |  |  |  |
| 2:0 | Max_LED_current | NVM     | R   | 011                          | 28mA                |  |  |  |  |
|     |                 |         |   | 100                          | 37mA                |  |  |  |  |
|     |                 |         |   | 101                          | 50mA                |  |  |  |  |
|     |                 |         |   | 110                          | 65mA                |  |  |  |  |
|     |                 |         | 111   | 80mA                         |                     |  |  |  |  |
| 6:3 |                 | 0h      | R   |                              | always 0, don't use |  |  |  |  |



Table 22. LED Configuration Register (Continued)

|     | A .d.d 40h               | LED Configuration Register |         |   |  |  |  |  |
|-----|--------------------------|----------------------------|---------|---|--|--|--|--|
|     | Addr: 12h                |                            | Set max | im AF   | LED current and configure indicator type                             |  |  |  |
| Bit | Bit Name                 | Default                    | Access  | Description   |  |  |  |  |
|     |                          |                            |         | Maximum Peak current limit measured on pin SW_F if automatic peak current regulation is performed |  |  |  |  |
|     |                          |                            |         | 000   | No peak current regulation done - default                            |  |  |  |
|     |                          |                            |         | 001   | 450mA  |  |  |  |
|     | switch_current_selection |                            |         | 010   | 525mA  |  |  |  |
| 5:3 | 5:3max                   | NVM                        | R       | 011   | 600mA  |  |  |  |
|     |                          |                            |         | 100   | 675mA  |  |  |  |
|     |                          |                            |         | 101   | 750mA  |  |  |  |
|     |                          |                            |         | 110   | 825mA  |  |  |  |
|     |                          |                            |         | 111   | 900mA  |  |  |  |
|     |                          |                            |         |   | Double value for switch_current_selection                            |  |  |  |
| 6   | switch_current_boost     | NVM                        | R       | 0   | I(SW_F) =switch_current_selection                                    |  |  |  |
|     |                          |                            |         | 1   | I(SW_F) = 2 * switch_current_selection                               |  |  |  |
|     |                          |                            |         |   | Indicator LED present; applies when indicator is switched on (IND=1) |  |  |  |
| 7   | 7 ILP NVM                | NVM                        | R/W     | 0   | use VLED output with AF_LED_current and AF_LED_PWM duty cycle        |  |  |  |
|     |                          |                            | 1       | use IND output with IND_LED_current; ILF (indicator LED fault) detection is enabled               |  |  |  |  |

Table 23. Password Register

|     | Addr: 13h         | Password Register  EEPROM writing password lock register |     |   |   |  |  |  |
|-----|-------------------|--|-----|---|---|--|--|--|
| Bit | Bit Name          | Default  |     | EPROW WITH  | Description   |  |  |  |
|     |                   | 00h  | R/W | Un-lock register for EEPROM writing - see EEPROM Writing Cycle on page 13 |   |  |  |  |
| 7:0 | Password_register |  |     | 138d  | Read: EEPROM writing pending Write: Unlock EEPROM writing for next I <sup>2</sup> C command |  |  |  |
|     |                   |  |     | 0137d,<br>139d255d  | EEPROM writing locked   |  |  |  |

Table 24. Photosensor Register

|     |                       | Photosensor Register  |     |                                  |                  |  |  |  |
|-----|-----------------------|---|-----|----------------------------------|------------------|--|--|--|
|     | Addr: 18h             | External Photosensor control - see Photosensor Detection circuit on page 16 |     |                                  |                  |  |  |  |
| Bit | Bit Name              | Default Access Description  |     |                                  |                  |  |  |  |
|     |                       | 00h   | R/W | Adjust photosensor off - voltage |                  |  |  |  |
| 6:0 | veone off voltage     |   |     | 0                                | VSENS_OFF = 1.1V |  |  |  |
| 0.0 | 6:0 vsens_off_voltage |   |     | •••                              |                  |  |  |  |
|     |                       |   |     | 127d                             | VSENS_OFF = 1.7V |  |  |  |



Table 24. Photosensor Register (Continued)

|     | Addr: 18h     |   | Photosensor Register  External Photosensor control - |  |                             |  |  |  |  |
|-----|---------------|---|--|--|-----------------------------|--|--|--|--|
| Bit | Bit Name      | See Photosensor Detection circuit on page 16     Default   Access   Description |  |  |                             |  |  |  |  |
|     |               |   |  | Enable the photosensor detection circuit - see Photosensor<br>Detection circuit on page 16 |                             |  |  |  |  |
| 7   | 7 phsens_on 0 | R/W   | 0  | disabled   |                             |  |  |  |  |
|     |               |   |  | 1  | photosensor circuit enabled |  |  |  |  |

Table 25. Xenon Voltage ADC

|     | Addr: 18h                    | Xenon Voltage ADC |   |  |  |  |  |  |
|-----|------------------------------|-------------------|---|--|--|--|--|--|
|     | Addr. 1011                   |                   | Measure last charged voltage of the Xenon charger |  |  |  |  |  |
| Bit | Bit Name                     | Default           | Default Access Description                        |  |  |  |  |  |
|     |                              | 00h R             | scaled volta                                      | ured voltage on Xenon charger (represents age on CFLASH) - only valid during charging RGE=1) <sup>1</sup> or right after end of charge |  |  |  |  |
| 6:0 | 6:0 xenon_charge_voltage 00h | 00h               | 0h R  | 0  | Vsw_r=lowest reading                                     |  |  |  |
|     |                              |                   |   | •••  |  |  |  |  |
|     |                              |                   |   | 127d   | Vsw_r=highest reading                                    |  |  |  |
|     |                              |                   |   | Xenon Cha  | arge ADC on - measures voltage on SW_F                   |  |  |  |
| 7   | xenon adc on                 | 0                 | R/W   | 0  | disabled   |  |  |  |
|     |                              |                   |   | 1  | Internal ADC running if xenon charger running (CHARGE=1) |  |  |  |

<sup>1.</sup> For reading of xenon\_charge\_voltage, CHARGE should be set to '0'. If reading of xenon\_charge\_voltage is required during CHARGE=1, read xenon\_charge\_voltage twice and compare the results. If both readings show the same result, the value is valid, otherwise re-start the readout.



# 9 Register Map

Table 26. Register Map

| Register<br>Definition             | Addr | Default |                         |   |          | Cor        | itent       |            |              |              |  |  |
|------------------------------------|------|---------|-------------------------|---|----------|------------|-------------|------------|--------------|--------------|--|--|
| Name                               |      |         | b7                      | b6  | b5       | b4         | b3          | b2         | b1           | b0           |  |  |
| IC Info Register                   | 00h  | 12h     | 0                       | 0   | 0        | 1          | 0           | 0          | 1            | 0            |  |  |
| IC Version Control<br>Register     | 01h  | 0Xh     | 0 0 0 Design_round      |   |          |            |             |            |              |              |  |  |
| Module Info Reg.A                  | 02h  | NVM     | Module                  | Module_Manufacturer_ID Module_Generation Module_Typ |          |            |             |            |              |              |  |  |
| Module Info<br>Register B          | 03h  | NVM     | Мо                      | Module_Project_Number                               |          |            |             |            |              | on           |  |  |
| Control Register                   | 04h  | 01h     | STDBY                   | RESET   | 0        | 0          | TORCH<br>_S | MST        | AFSTR<br>OBE | WATCH<br>DOG |  |  |
| Interrupt Mask<br>Register         | 05h  | FFh     | SSTFI                   | READY<br>FI   | AFFI     | OTPFI      | TOFI        | BCFI       | CTFI         | ILFI         |  |  |
| Interrupt Status<br>Register       | 06h  | 00h     | SSTF                    | READY<br>F  | AFF      | OTPF       | TOF         | BCF        | CTF          | ILF          |  |  |
| Xenon Control<br>Register          | 07h  | 00h     | 0                       | 0   | 0        | 0          | CAR         | STROB<br>E | READY        | CHARG<br>E   |  |  |
| Xenon CAR<br>Interval Register     | 08h  | 01h     | 0 0 0 0 CAR_interval    |   |          |            |             |            |              | ⁄al          |  |  |
| Xenon Charge<br>Time Register      | 09h  | 00h     |                         | charge_time   |          |            |             |            |              |              |  |  |
| Xenon SST Pulse<br>Length Register | 0Ah  | NVM     |                         |   | xer      | non_SST_   | _pulse_ler  | ngth       |              |              |  |  |
| Xenon Life Time<br>Register MSB    | 0Bh  | NVM     |                         |   | xe       | non_life_d | counter_M   | SB         |              |              |  |  |
| Xenon Life Time<br>Register LSB    | 0Ch  | NVM     |                         |   | xe       | non_life_d | counter_L   | SB         |              |              |  |  |
| Xenon Config<br>Register A         | 0Dh  | NVM     | 0                       | 0   |          | cha        | arge_volta  | ge_selec   | tion         |              |  |  |
| Xenon Config<br>Register B         | 0Eh  | NVM     | IGBT_fall2<br>zero_slow |   | extend   | l_pulse    |             | switch_    | _current_s   | election     |  |  |
| Xenon Config<br>Register C         | 0Fh  | NVM     | coil_pea                | k_current   | IGBT_ris | se_and_fa  | II_speed    | IGBT_      | _fall_spee   | d2zero       |  |  |
| LED Current<br>Register            | 10h  | 00h     | IND_LE                  | O_current   | AF       | _LED_PV    | VM          | AF.        | _LED_cur     | rent         |  |  |
| LED Control<br>Register            | 11h  | 00h     | 0                       | 0   | 0        | 0          | AF          | PWM        | INDP         | IND          |  |  |
| LED Configuration<br>Register      | 12h  | NVM     | ILP                     | switch_<br>current_<br>boost                        | switch_c | urrent_sel | ection_m    | Мах        | _LED_cu      | rrent        |  |  |
| Password<br>Register               | 13h  | 00h     |                         |   |          | Passwore   | d_register  |            |              |              |  |  |
| General Purpose<br>OTP 1           | 14h  | NVM     |                         |   |          | User       | defined     |            |              |              |  |  |
| General Purpose<br>OTP 2           | 15h  | NVM     |                         |   |          | User       | defined     |            |              |              |  |  |



Table 26. Register Map (Continued)

| Register<br>Definition  | Addr | Default | Content          |                      |  |  |  |  |  |  |  |
|-------------------------|------|---------|------------------|----------------------|--|--|--|--|--|--|--|
| Name                    |      |         | b7               | b6 b5 b4 b3 b2 b1 b0 |  |  |  |  |  |  |  |
| Photosensor<br>Register | 18h  | 00h     | phsens<br>_on    | vsens_off_voltage    |  |  |  |  |  |  |  |
| Xenon Voltage<br>ADC    | 19h  | 00h     | xenon_<br>adc_on | xenon_charge_voltage |  |  |  |  |  |  |  |

NVM...Non Volatile Memory using internal EEPROM; for programming see EEPROM Writing Cycle on page 13, don't read or write during life time counter updates

Upon delivery the EEPROM default value are set according to Table 27:

Table 27. EEPROM default settings

| Register<br>Definition             | Addr | Default | Content                      |  |          |          |             |                    |          |    |
|------------------------------------|------|---------|------------------------------|--|----------|----------|-------------|--------------------|----------|----|
| Name                               |      |         | b7                           | b6   | b5       | b4       | b3          | b2                 | b1       | b0 |
| Module Info Reg.A                  | 02h  | 05h     | Module                       | _Manufac                                     | turer_ID | Modi     | ule_Gener   | ration Module_Type |          |    |
| Module Info<br>Register B          | 03h  | 00h     | Мо                           | Module_Project_Number                        |          |          |             |                    | on       |    |
| Xenon SST Pulse<br>Length Register | 0Ah  | 08h     |                              | xernon_SST_pulse_length                      |          |          |             |                    |          |    |
| Xenon Life Time<br>Register MSB    | 0Bh  | 00h     |                              | xenon_life_counter_MSB                       |          |          |             |                    |          |    |
| Xenon Life Time<br>Register LSB    | 0Ch  | 00h     | xenon_life_counter_LSB       |  |          |          |             |                    |          |    |
| Xenon Config<br>Register A         | 0Dh  | 00h     | 0 0 charge_voltage_selection |  |          |          |             |                    |          |    |
| Xenon Config<br>Register B         | 0Eh  | 86h     | IGBT_fall2<br>zero_slow      |  |          |          | switch_     | _current_s         | election |    |
| Xenon Config<br>Register C         | 0Fh  | 80h     | coil_peal                    | coil_peak_current   IGBT_rise_and_fall_speed |          | IGBT_    | _fall_speed | d2zero             |          |    |
| LED Configuration<br>Register      | 12h  | 07h     | ILP                          | ILP switch_current_selection_m ax Max        |          | c_LED_cu | rent        |                    |          |    |
| General Purpose<br>OTP 1           | 14h  | 00h     | User defined                 |  |          |          |             |                    |          |    |
| General Purpose<br>OTP 2           | 15h  | 00h     | User defined                 |  |          |          |             |                    |          |    |



# **10 Application Information**

## **External Components**

#### Transformers Tcharge and Trrig

Following transformers are recommend for the AS3636 (due to the programming features the output voltage VFLASH can be programmed):

Table 28. Recommended Transformers

| Component       | Part Number | N    | L    | Size (mm)        | Manufacturer                       |
|-----------------|-------------|------|------|------------------|------------------------------------|
|                 | TTRN-3825H  | 10.2 | 7µH  | 3.8x3.8x2.5      | Tokyo Coil                         |
|                 | TTRN-3822H  | 10.2 | 7µH  | 3.8x3.8x2.2      | www.tokyo-coil.co.jp               |
| <b>T</b> CHARGE | C3-T2.5R    | 10.2 | 7µH  | 3.4x3.4x2.5      | Mitsumi<br>www.mitsumi.co.jp       |
|                 | LDT4520T-01 | 10.2 | 10µH | 4.7x4.5x2.0      | TDK<br>www.tdk.com                 |
| <b>T</b> TRIG   | BO-02       |      | •    | 7.3x2.5(3.5)x2.2 | Tokyo Coil<br>www.tokyo-coil.co.jp |

Always check if the voltage on the pin SW\_F does never exceed the AS3636 maximum Vsw (see Table 3 on page 4) specification during charging.

#### **IGBT**

As the AS3636 has an internal DCDC step up included, 2.5V and 4V IGBT can be used without limit on the supply VVBAT. The IGBT is used for two purposes:

- Powering of the Xenon tube and generating together with the oscillation circuit consisting of TTRIG, CTRIG, RTRIG a sufficiently high trigger pulse to ignite the Xenon tube (about 3.5kV) - this is accomplished by a fast rising edge of the gate of the IGBT
- 2. Switching off the current through the Xenon tube at the end of the flash pulse to accurately control the light emitted by the flash. To protect the IGBT the switching off falling edge voltage should be less than  $400V/\mu s$  (measured on the emitter of the IGBT)

Both requirements are achieved with the internal driving circuit of the AS3636. Trimming allows to adopt to different trigger coils and IGBTs.

Table 29. Recommended IGBTs

| Component     | Part Number | min. Drive Voltage | Size                   | Manufacturer                         |
|---------------|-------------|--------------------|------------------------|--------------------------------------|
|               | RJP4002ANS  | 2.5V               | VSON-8                 | _                                    |
|               | RJP4003ANS  | 4.0V               | 3 x 4.8mm              | Renesas<br>www.renesas.com           |
|               | RJP4006ANS  | 2.5V               | 2.85x2.95mm            |                                      |
| <b>Q</b> IGBT | GT8G133     | 4.0V               | TSSOP-8<br>3.3 x 6.4mm | Toshiba<br>www.semicon.toshiba.co.jp |
|               | TIG058E8    | 4.0V               | ECH8<br>2.8 x 2.9mm    | Sanyo<br>www.sanyo.com               |

#### Photoflash Capacitor CFLASH

The photoflash capacitor stores the energy for the flash. Its capacitance define the maximum available energy. Using higher value capacitors as shown in Table 30 is possible, but will increase the charging time.



It is recommended to use low ESR capacitors to avoid loosing power during flash (it is also possible to connect two capacitors in parallel to reduce ESR):

Table 30. Recommended Photoflash Capacitors

| Component | Part Number    | Capacitor             | Voltage rating | Size                             | Manufacturer                 |
|-----------|----------------|-----------------------|----------------|----------------------------------|------------------------------|
| CFLASH    | 330FW13A6.3X20 | 2x13.5µF <sup>1</sup> | 330V           | Cylinder<br>2 x l=24mm,<br>d=7mm | Rubycon<br>www.rubycon.co.jp |

Different capacitor values are possible to be used together with the AS3636. Lower capacitor value will reduce charging time, lower ESR capacitor will improve light output energy and reduce losses in the capacitor during the flash pulse.

#### Photoflash Charger rectification diode DCHARGE

The rectification diode should have very low parasitic capacitance <sup>19</sup> and has to withstand the operating current and reverse voltages.

Table 31. Recommended Rectification Diodes

| Component       | Part Number | Parasitic<br>Capacitor | Voltage rating | Size                | Manufacturer               |
|-----------------|-------------|------------------------|----------------|---------------------|----------------------------|
|                 | FVO2R80     | 5pF                    | 800V           | 1.25x2.5mm          | Origin<br>www.origin.co.jp |
| <b>D</b> CHARGE | GSD2004S    | 5pF / 2                | 2x240V         | SOT-23<br>2.4x3.0mm | Vishay<br>www.vishay.com   |
|                 | BAS21       | 5pF / 2                | 2x250V         | SC-70<br>2.0x2.1mm  | OnSemi<br>www.onsemi.com   |

#### Supply Capacitor CVBAT and DCDC Boost capacitor CVOUTBOOST

Low ESR capacitors should be used to minimize VBAT ripple. Multi-layer ceramic capacitors are recommended since they have extremely low ESR and are available in small footprints. The capacitor should be located as close to the device as possible.

X5R dielectric material is recommended due to their ability to maintain capacitance over wide voltage and temperature range.

Table 32. Recommended CVBAT and CVOUTBOOST Capacitor

| Component     | Part Number     | С                       | TC Code | Rated<br>Voltage | Size | Manufacturer             |
|---------------|-----------------|-------------------------|---------|------------------|------|--------------------------|
| <b>C</b> VBAT | GRM188R60J126   | 10μF<br>>5.5μF<br>@1.8V | X5R     | 6.3V             | 0603 | Murata<br>www.murata.com |
| CVOUTBOOST    | C1608X5R 0J106M | 10µF                    | X5R     | 6.3V             | 0603 | TDK<br>www.tdk.com       |

If a different output capacitor is chosen, ensure low ESR values and voltage ratings.

<sup>19.</sup>A low parasitic capacitance improves charging efficiency.



#### Inductor LDCDC

The fast switching frequency (2MHz) of the AS3636 allows for the use of small SMDs for the external inductor. The inductor should have low DC resistance (DCR) to reduce the I<sup>2</sup>R power losses - high DCR values will reduce efficiency.

Table 33. Recommended Inductor

| Part Number | L     | DCR   | L @ 0.5A | Size                   | Manufacturer             |
|-------------|-------|-------|----------|------------------------|--------------------------|
| LQM21PN2R2  | 2.2µH | 240mΩ | >1.5µH   | 2x1.25x0.9mm<br>(0805) | Murata<br>www.murata.com |

If a different inductor is chosen, ensure similar DCR values and at least 1.5µH inductance at 0.5A input current.

## **PCB Layout Guideline**

Following layout recommendations apply:

- Keep the path (and area) of GND (SGND directly connected to DGND below the WL-CSP) CVBAT VBATINT

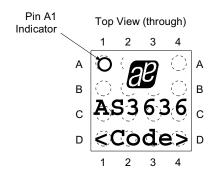
   TCHARGE(primary) SW\_F GND as short as possible to minimize the leakage inductance of TCHARGE and ensure a proper supply connection for the AS3636
- 2. Keep the path (and area) of GND CVBAT LBOOST SW\_B VOUTBOOST CVOUTBOOST GND as short as possible.
- 3. Place CVBAT as close as possible to the AS3636.
- 4. Ensure wide and short PCB paths for the path GND CFLASH XFLASH QIGBT GND to allow 150A to flow during the flash pulse. Connect this GND only at a single place to the main GND plane.
- 5. The IGBT has two ground connections: One ground for the driving input and one ground for the power path.
- 6. Ensure larger spacings for all high voltage paths; check with the PCB manufacturer to ensure proper minimum spacing for 320V paths and 4kV (Xenon tube trigger pin) paths.
- 7. Minimize the parasitic capacitance of the PCB on the anode of DCHARGE especially to GND and VFLASH
- 8. See austriamicrosystems "WLP-CSP-Handling-Guidelines\_1V0.pdf" for proper handling, PCB layout and soldering of the WL-CSP AS3636 device.
- 9. In order to meet system level ESD protection careful routing of the ground lines, supply capacitor CVBAT and supply lines is required.

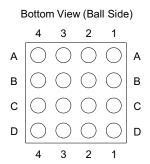
See austriamicrosystems demoboard layout (described in application note 'AN3636').



# 11 Package Drawings and Markings

Figure 20. 16pin WL-CSP 2x2.15mm Marking





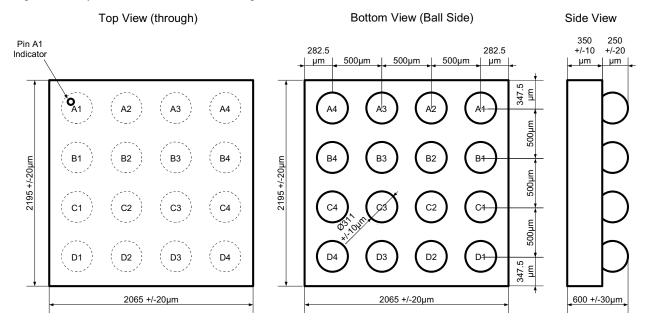
Note:

Line 1: austriamicrosystems logo

Line 2: AS3636 Line 3: <Code>

Encoded Datecode (4 characters)

Figure 21. 16pin WL-CSP 2x2.15mm Package Dimensions



The coplanarity of the balls is  $40\mu m$ .



# **12 Ordering Information**

The devices are available as the standard products shown in Table 34.

Table 34. Ordering Information

| Model       | Description  | Delivery Form | Package   |
|-------------|--|---------------|---|
| AS3636-ZWLT | Xenon Driver IC with LED Driver and Life Time<br>Counter | Tape & Reel   | 16-pin WL-CSP<br>(2mm x 2.15mm)<br>RoHS compliant / Pb-Free |

Note: AS3636-ZWLT

AS3636

Z Temperature Range: -30°C - 85°C

WL Package: Wafer Level Chip Scale Package (WL-CSP) 2x2.15mm

T Delivery Form: Tape & Reel



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